

# 微纳光电子材料与器件工艺原理

## Materials: Structures and Synthesis

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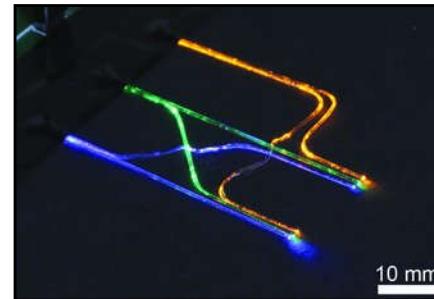
# Optical and Electronic Devices



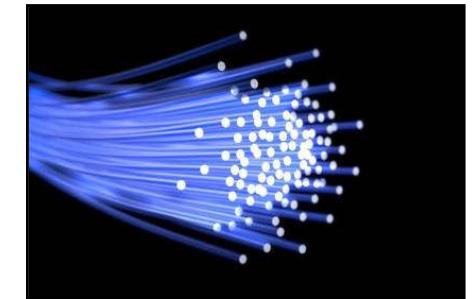
LEDs



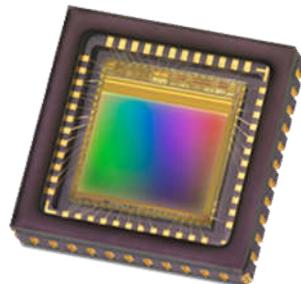
lasers



waveguides



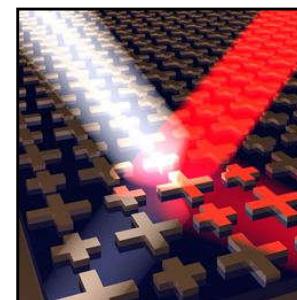
fibers



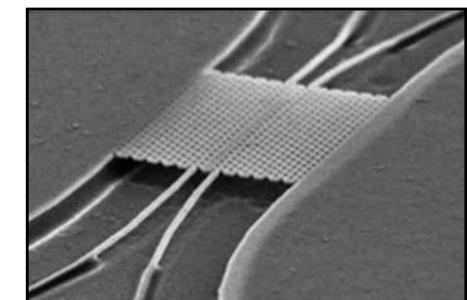
detectors



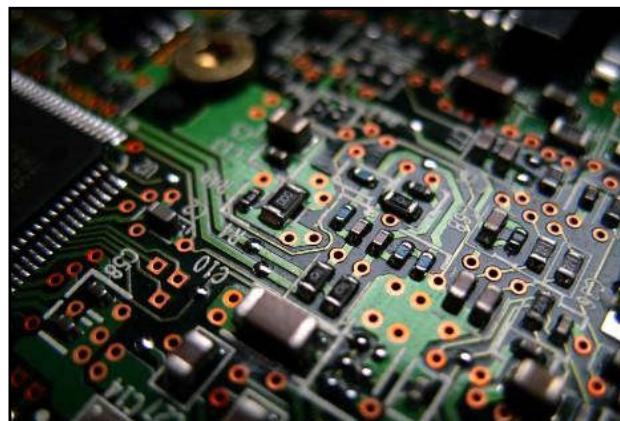
solar cells



metamaterials



photonic crystals



integrated circuits

Airflow  
SensorsCurrent  
SensorsFiber Optics and  
Liquid Level SensorsHumidity  
Sensors

Infrared Sensors

Magnetic  
Sensors

Flexible Heaters

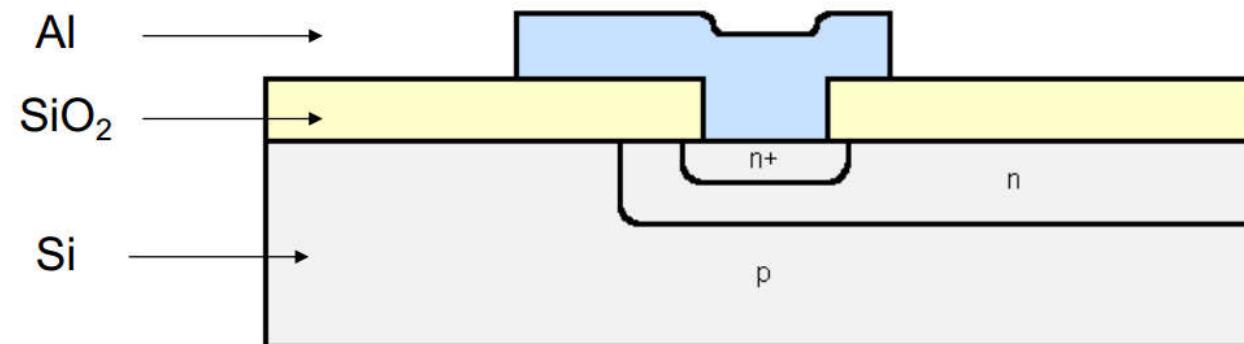


Force Sensors

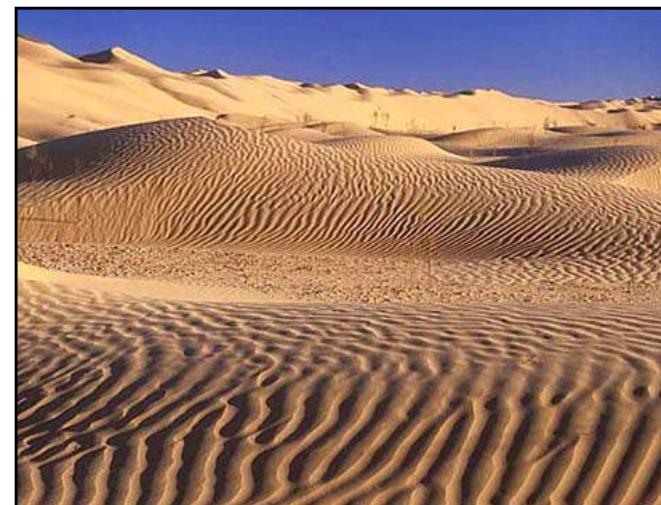
Proximity  
SensorsRotary Position  
SensorsSpeed  
Sensors

# Raw Materials

**MOS:** Metal-Oxide-Semiconductor



**Silicon**

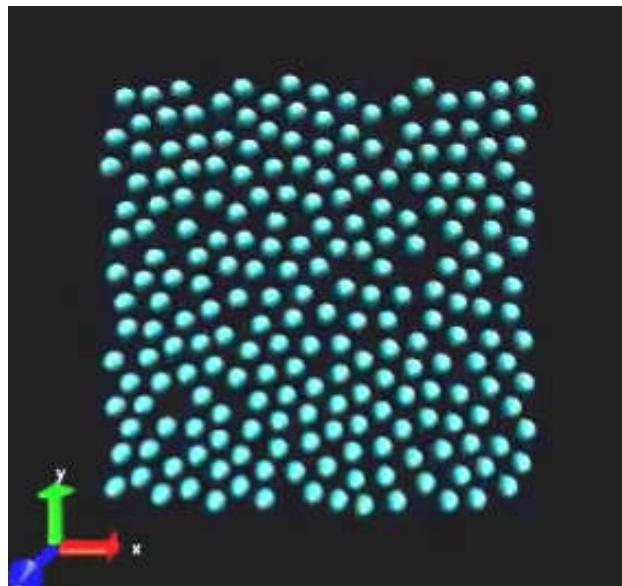
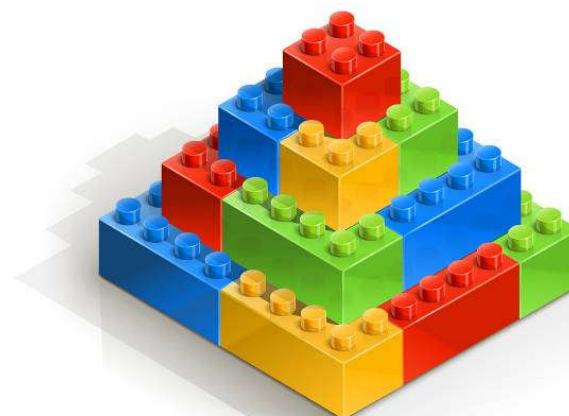


**$\text{SiO}_2$**

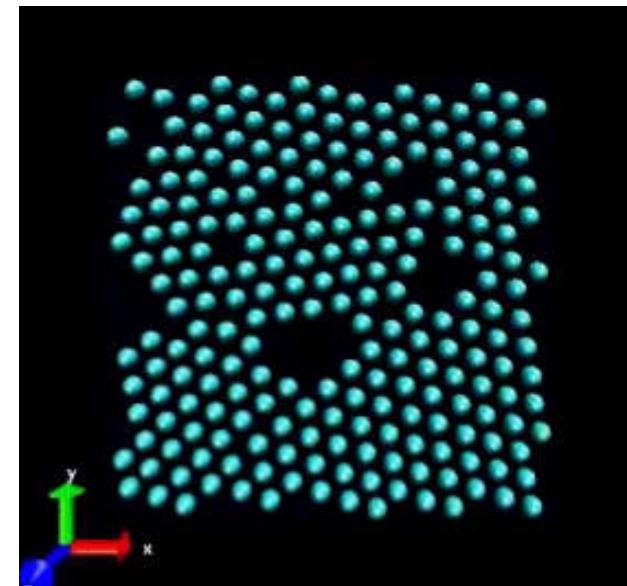


**Metal**

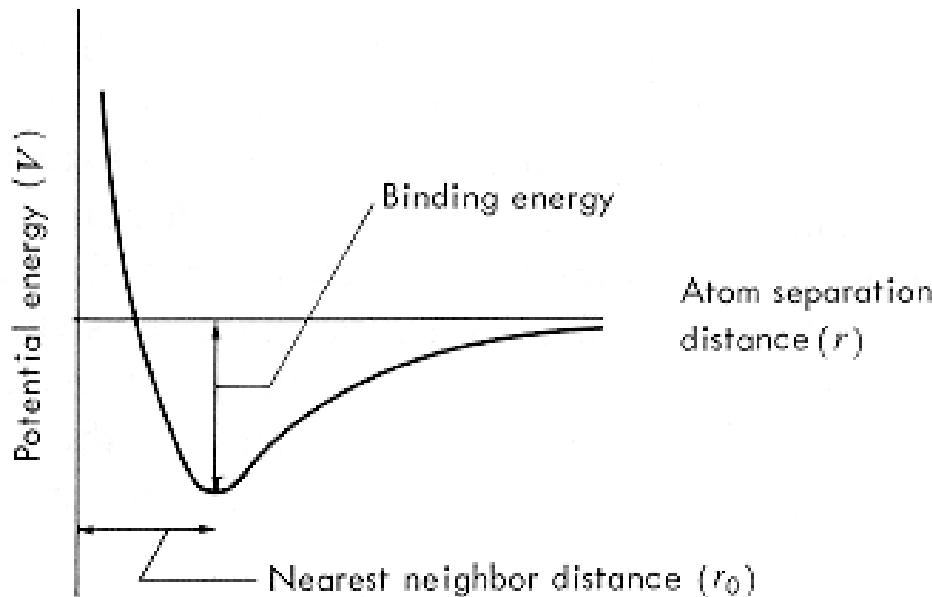
# Crystal Structures



→  
video

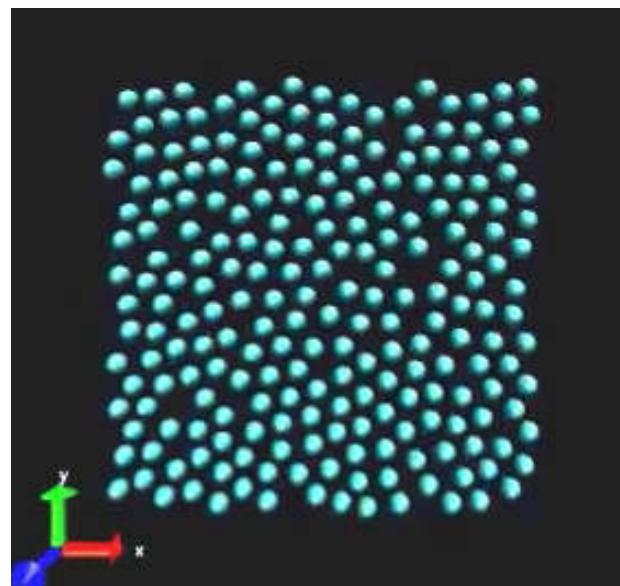


# It is all about *energy*

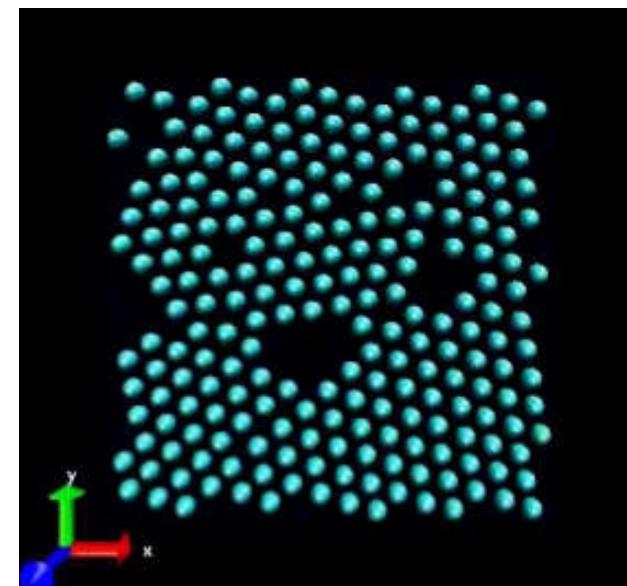


Lennard-Jones Potential

$$V(r) = \frac{A}{r^{12}} - \frac{B}{r^6}$$

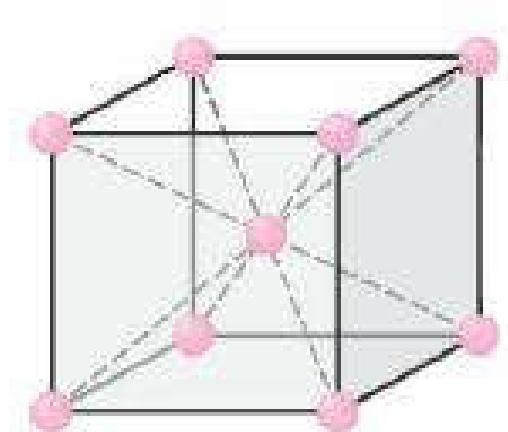


→  
video



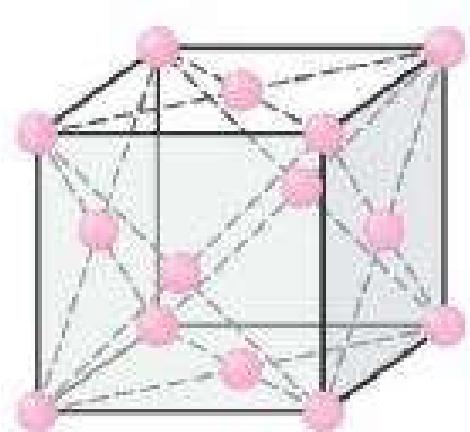
# Crystal Structures

Li, Na, Cr,...



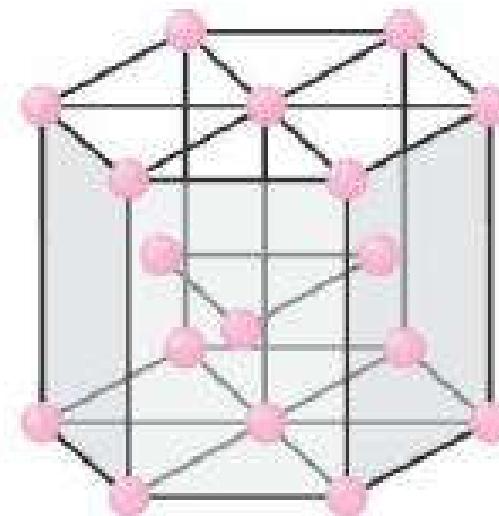
BCC

Al, Cu, Au,...



FCC

Mg, Zn, Ti,...



HCP

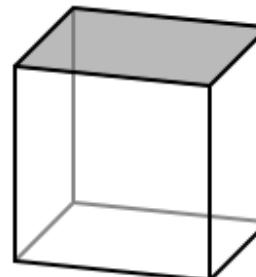
- 3D:
  - 14 Bravais lattices
  - 32 point groups
  - 230 space groups

# Miller Indices

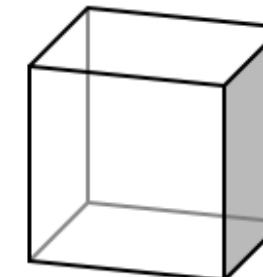
$(lmn)$  plane

intercepts at

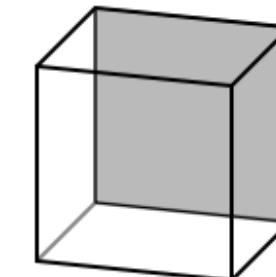
$a_1/l, a_2/m, a_3/n$



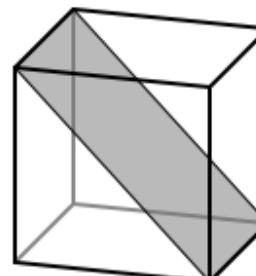
(001)



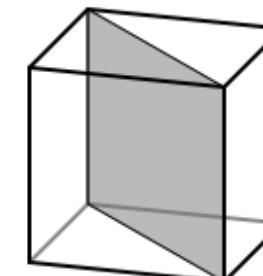
(100)



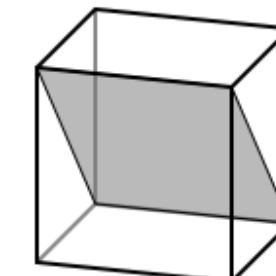
(010)



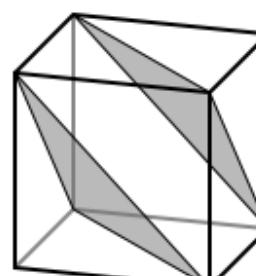
(101)



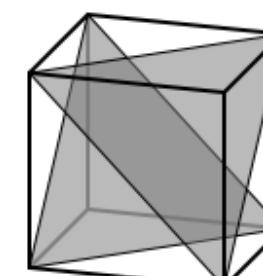
(110)



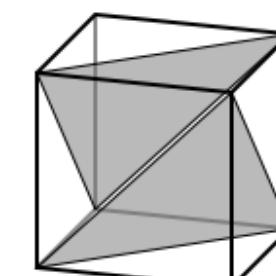
(011)



(111)



(1-11)



(-111)

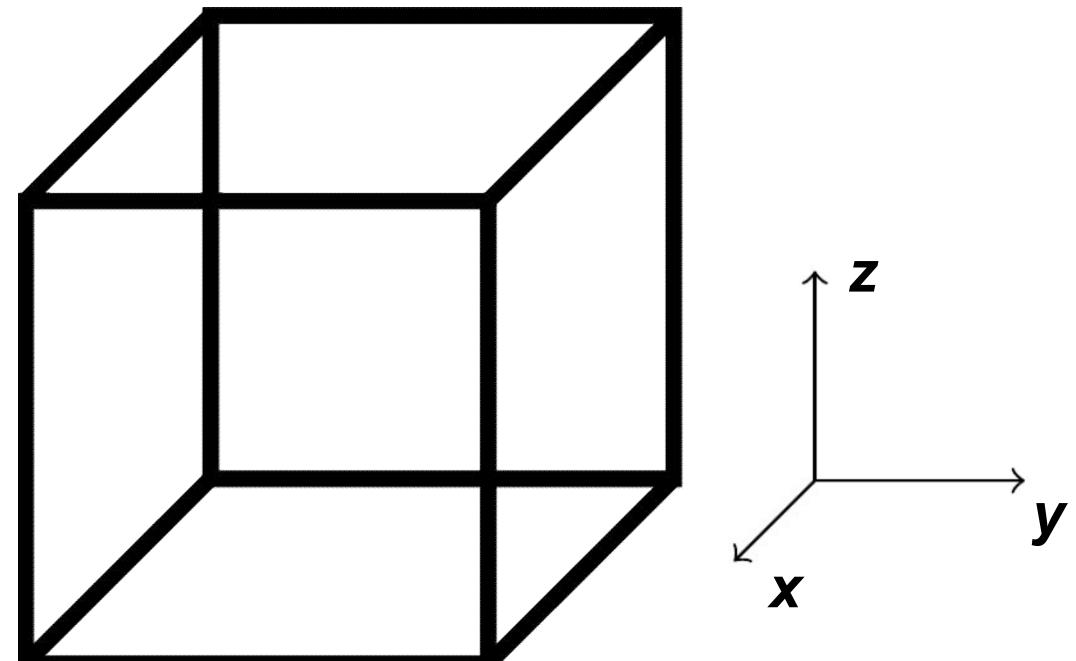
# Exercise in class

- draw planes below
  - (120), (112), (131)

$(lmn)$  plane

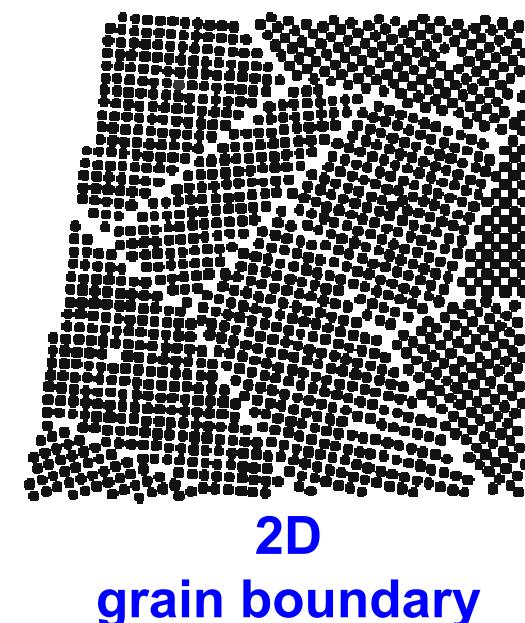
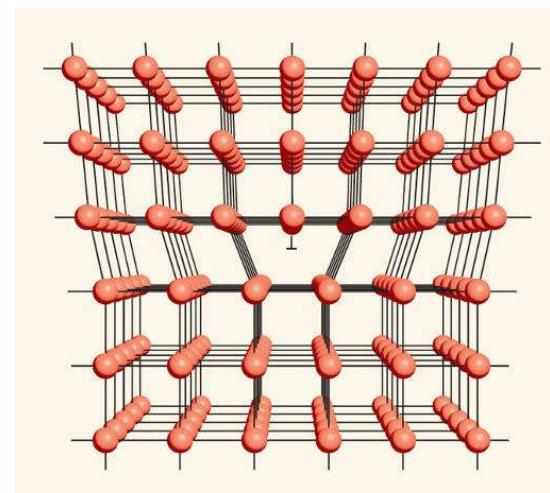
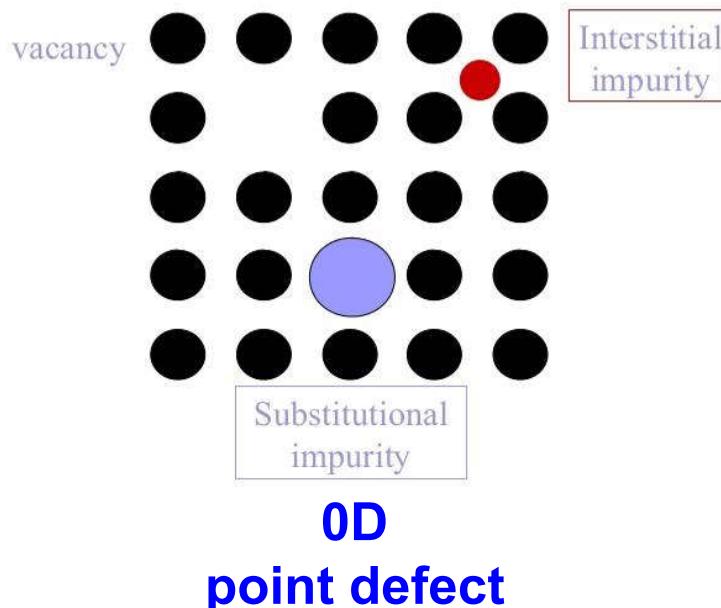
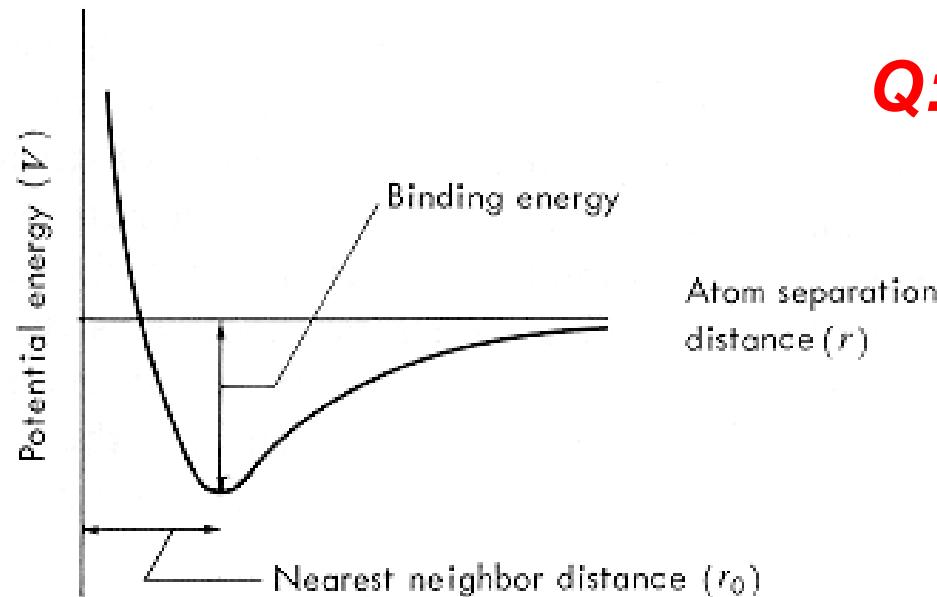
intercepts at

$a_1/l, a_2/m, a_3/n$

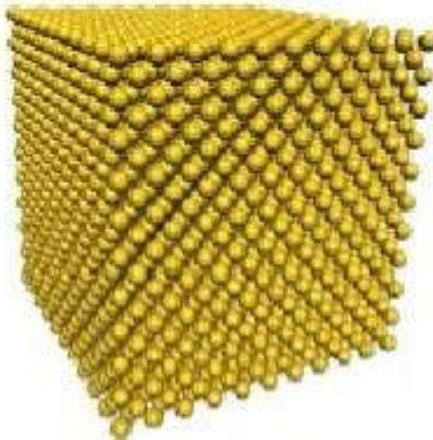


# Defects in Crystals

**Q: why?**



# Single Crystal (Mono Crystal)



Quartz

Sugar



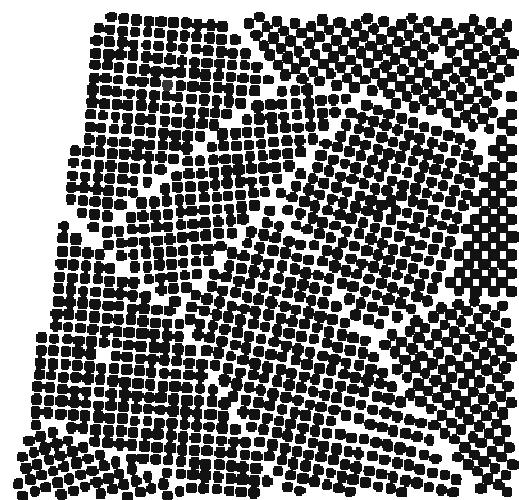
Silicon wafers,  
GaAs, GaN, sapphire, ...



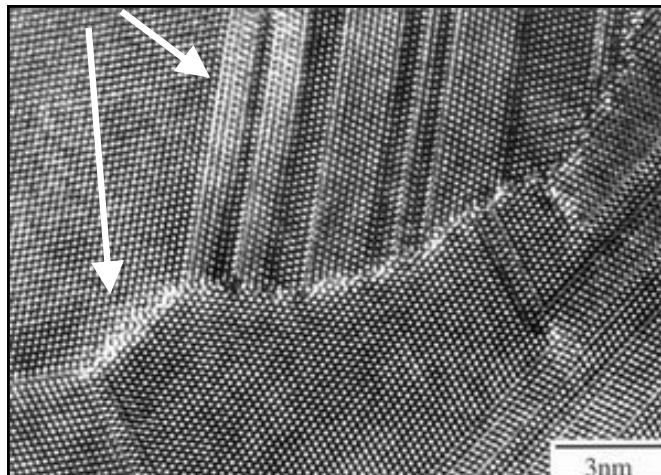
turbine blade



# Polycrystal



grain boundary



polycrystalline silicon



Poly-Crystalline  
Solar Cell



Mono-Crystalline  
Solar Cell



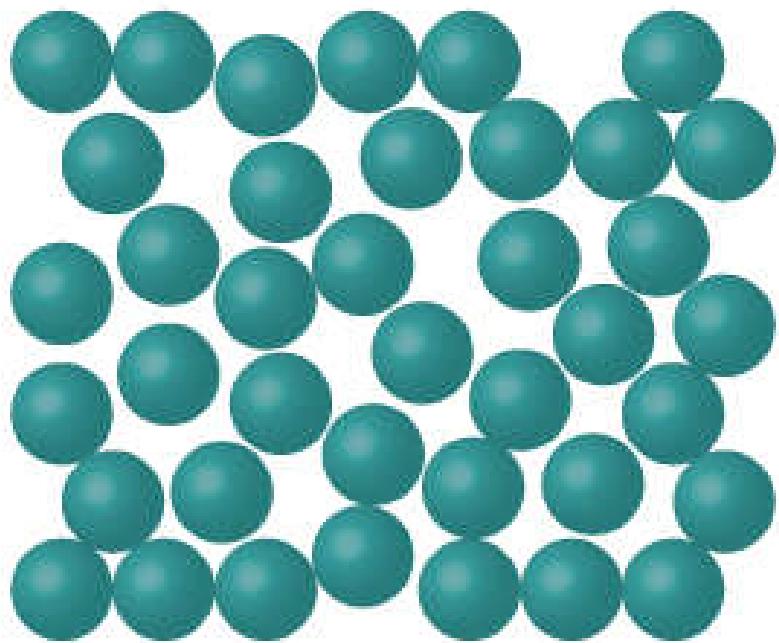
metal



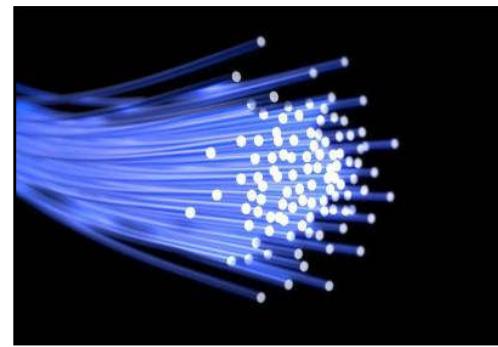
ceramic

# Amorphous Materials

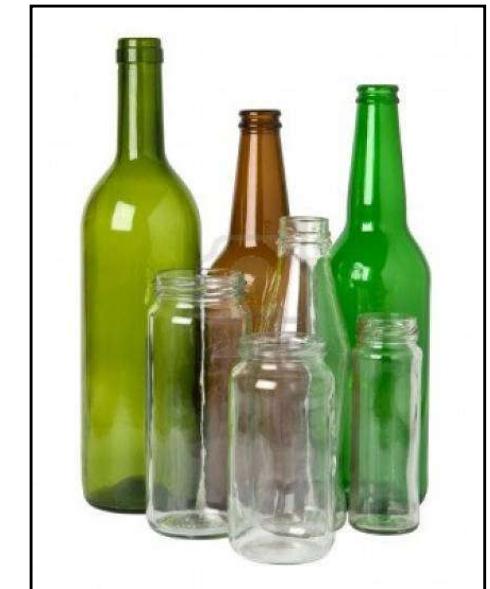
- Defects are everywhere ...



Amorphous



silica fiber



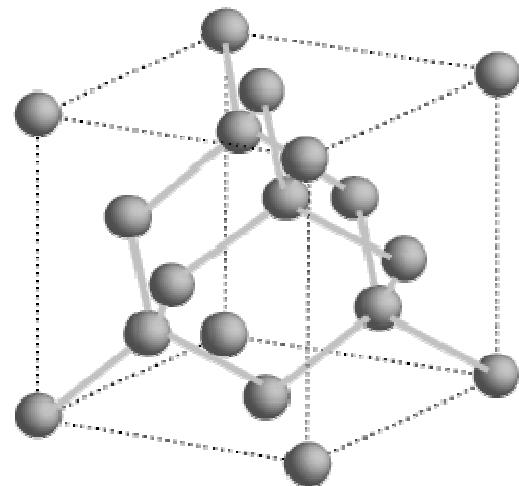
glass



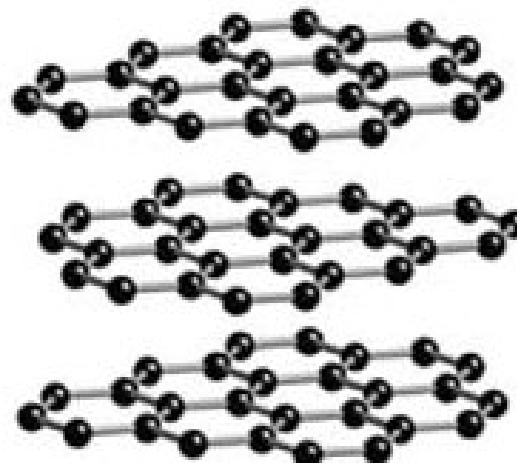
plastics

**Q: why is glass transparent?**

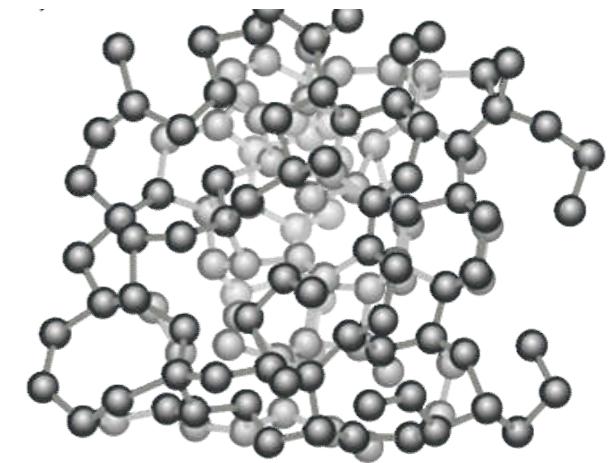
# Carbon



diamond



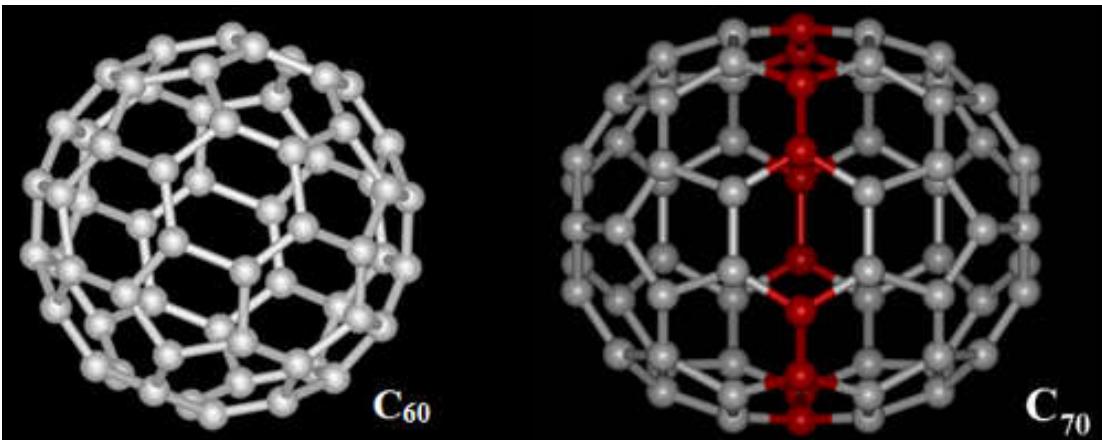
graphite



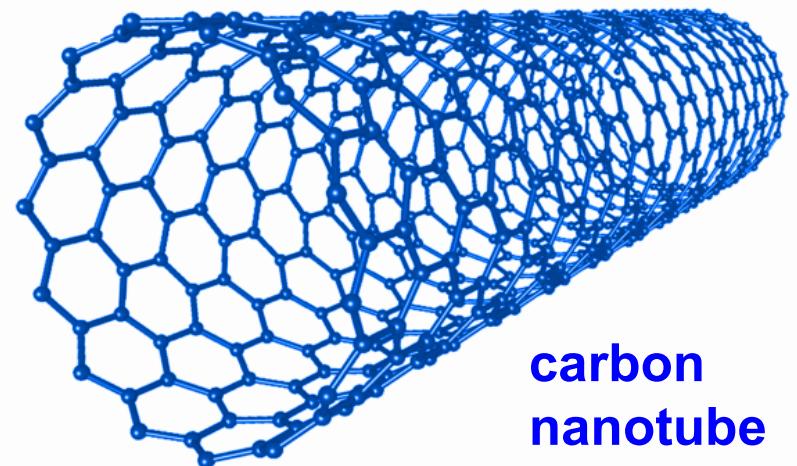
amorphous  
carbon

**Q: which one is electrically conductive, diamond or graphite?**

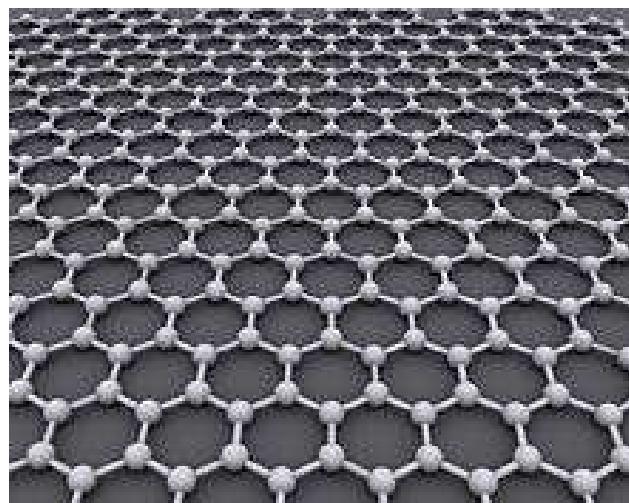
# Carbon



H. Kroto, R. Curl, R. Smalley  
1996 Nobel Prize in Chemistry



S. Iijima, *Nature* 354, 56 (1991)

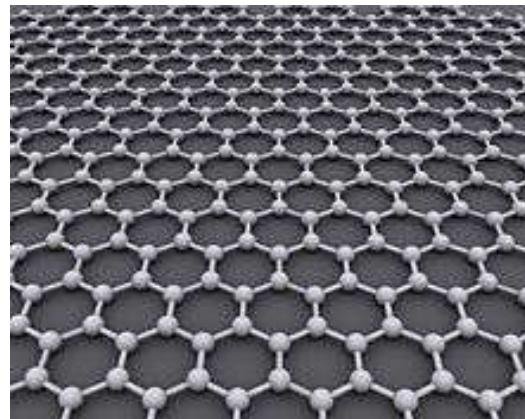


graphene

A. Geim, K. Novoselov  
2010 Nobel Prize in Physics

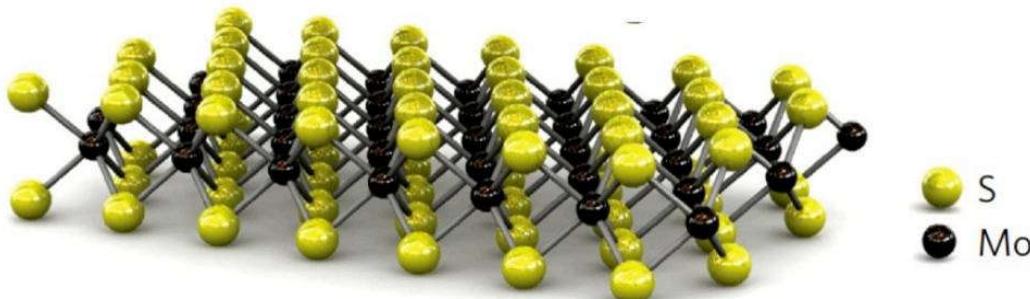
# 2D Materials

- Single atomic layer crystal

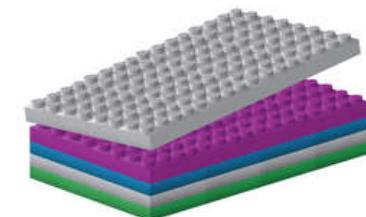
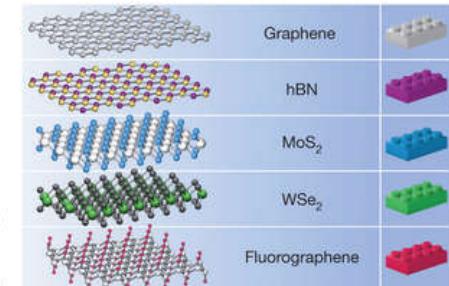
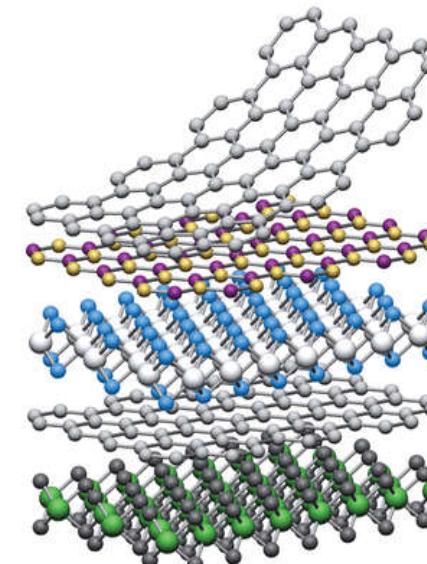


graphene

A. Geim, K. Novoselov  
2010 Nobel Prize in Physics

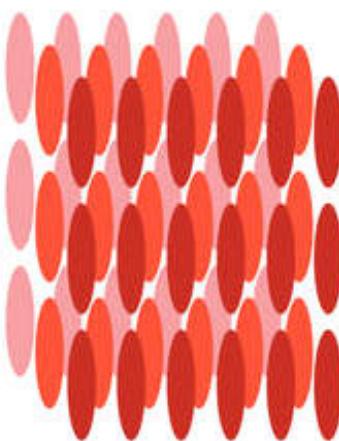


Transition metal dichalcogenide (TMDC)  
 $\text{MoS}_2$ ,  $\text{WSe}_2$ , ...

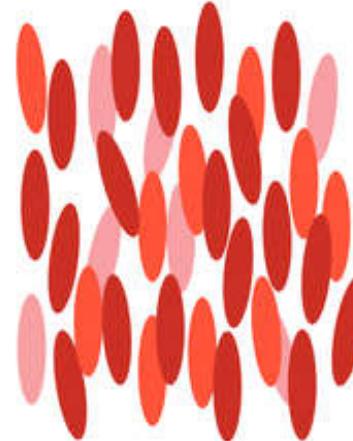


# Liquid Crystals

Crystalline Solid



Liquid Crystal



Isotropic Liquid



## Liquid crystal display (LCD)

P. de Gennes  
1991 Nobel Prize in Physics

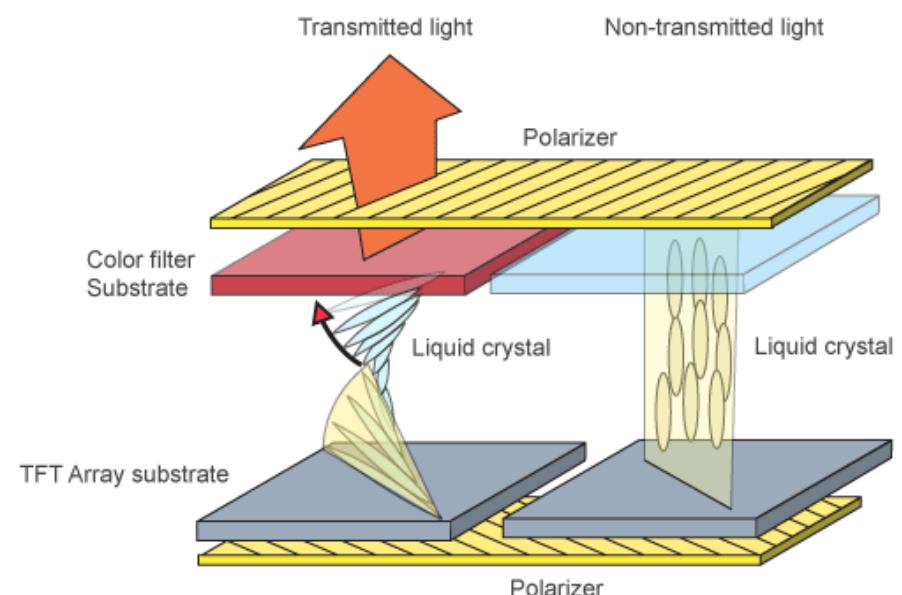
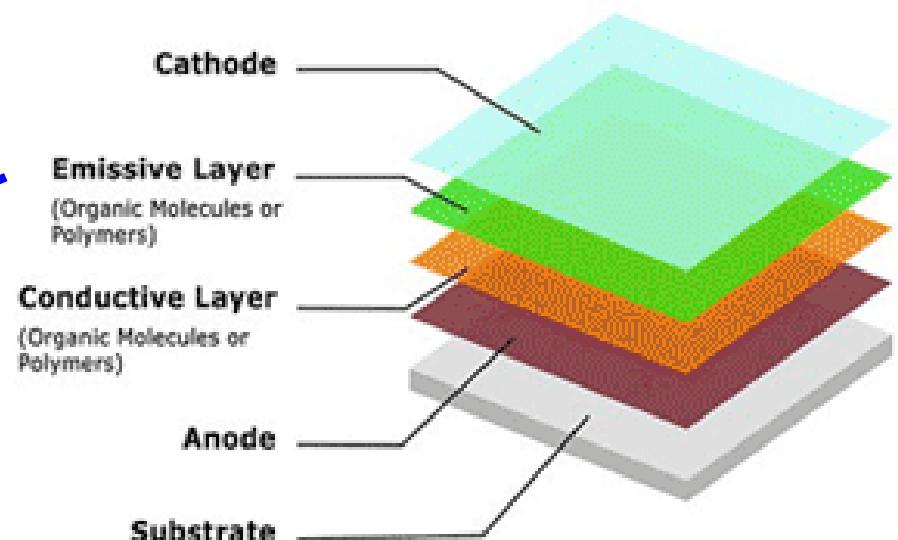
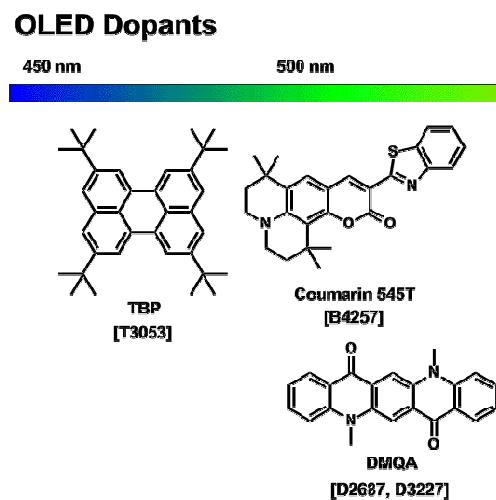


Diagram 2: The Fundamental Photonics of Liquid Crystal (Twisted Nematics)

# Organic Materials

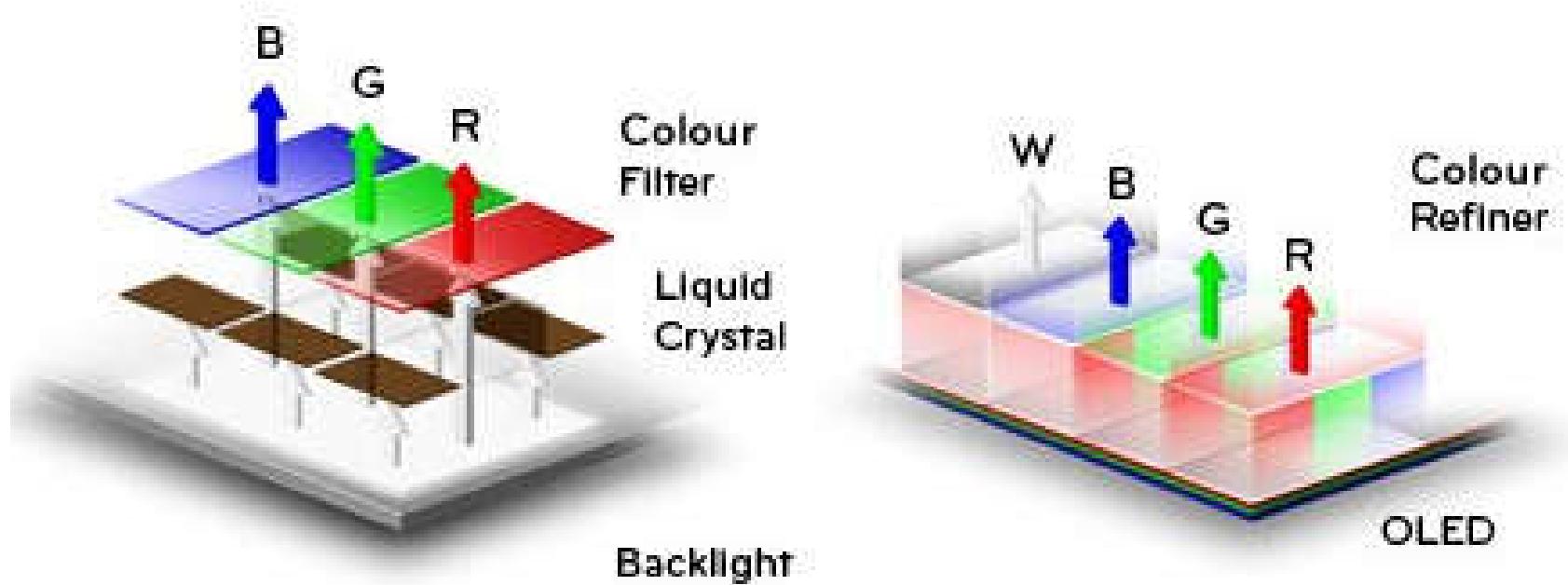
## ■ Small Molecules



**OLED**

# Organic Materials

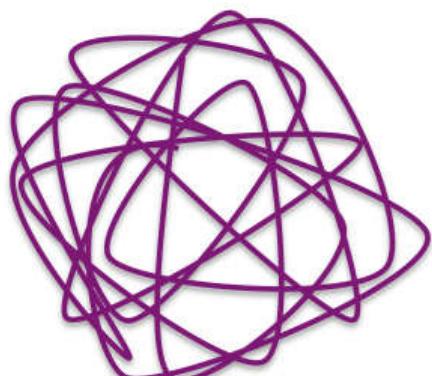
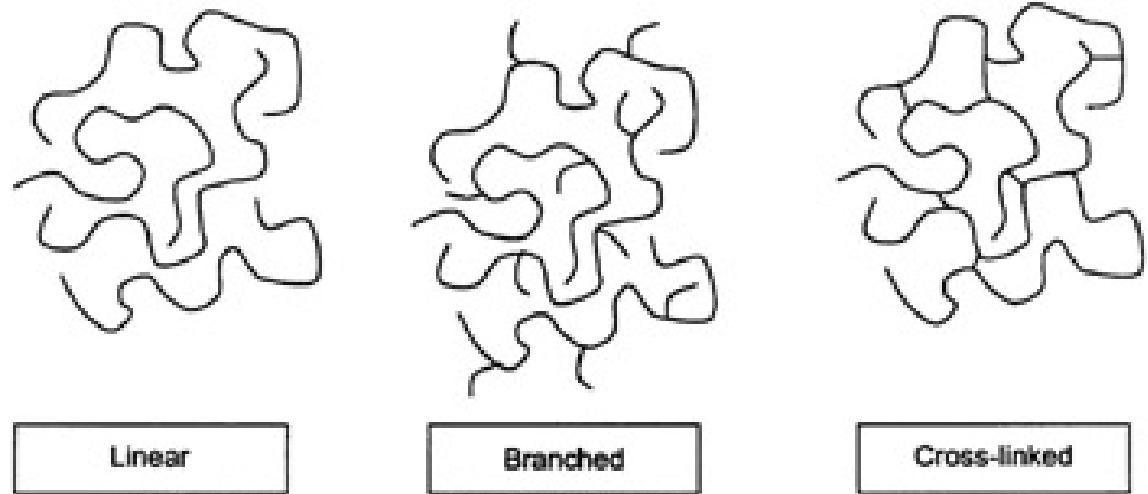
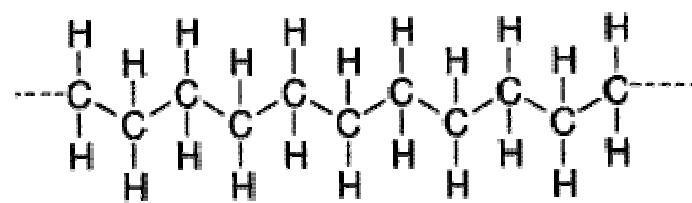
## LCD vs. OLED



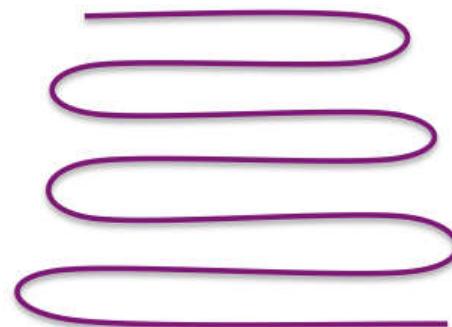
- Complex Structure
- BLU (Backlight Unit) CCFL, LED
- Lighting Unit = Pixel Unit
- Simple Structure
- Self-emissive
- Lighting Unit = Pixel Unit

# Organic Materials

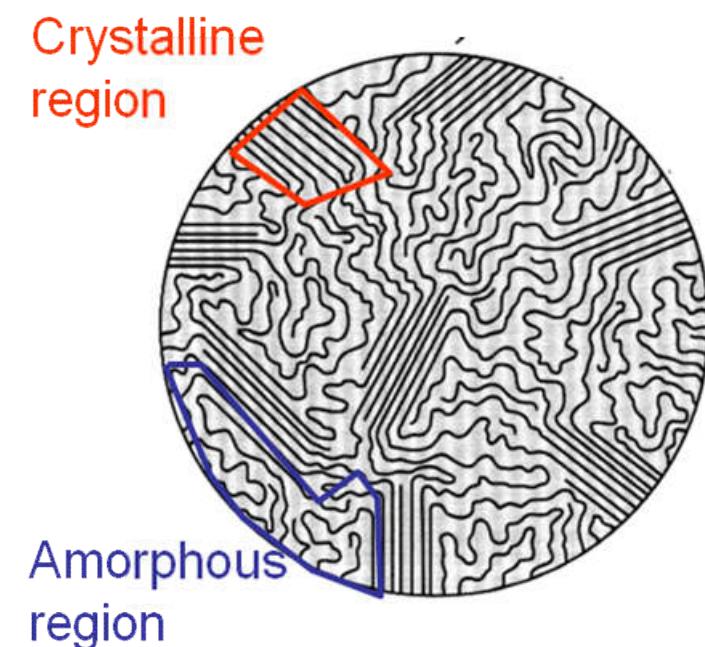
## ■ Polymers



Amorphous



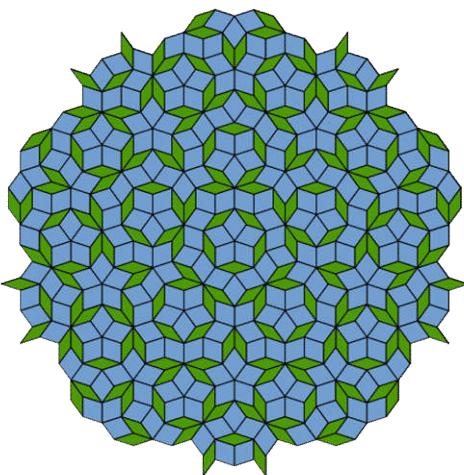
Crystalline



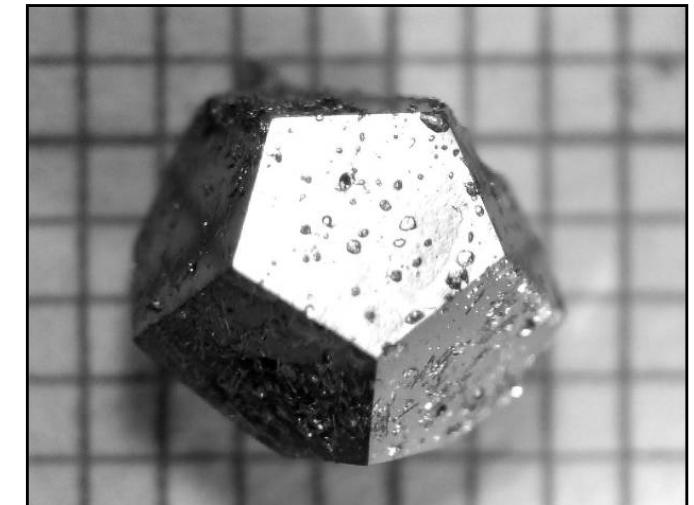
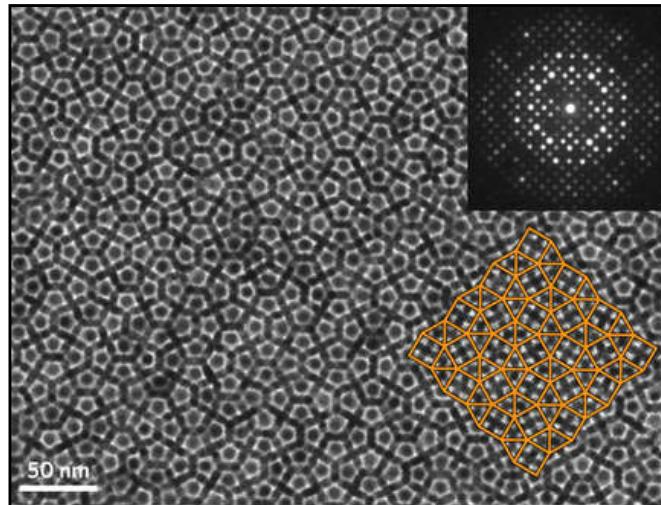
Amorphous region

# Quasi-Crystal

- Neither crystalline nor amorphous
  - 5, 8, 10, or 12-fold symmetry



Penrose tiling



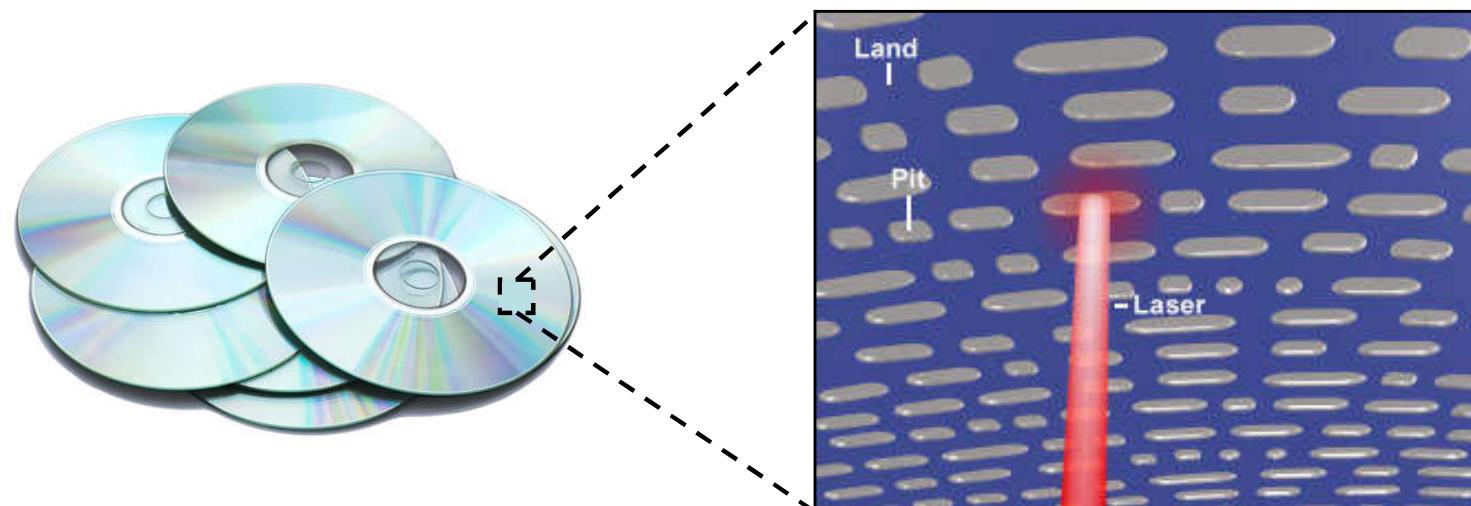
A Ho-Mg-Zn quasicrystal



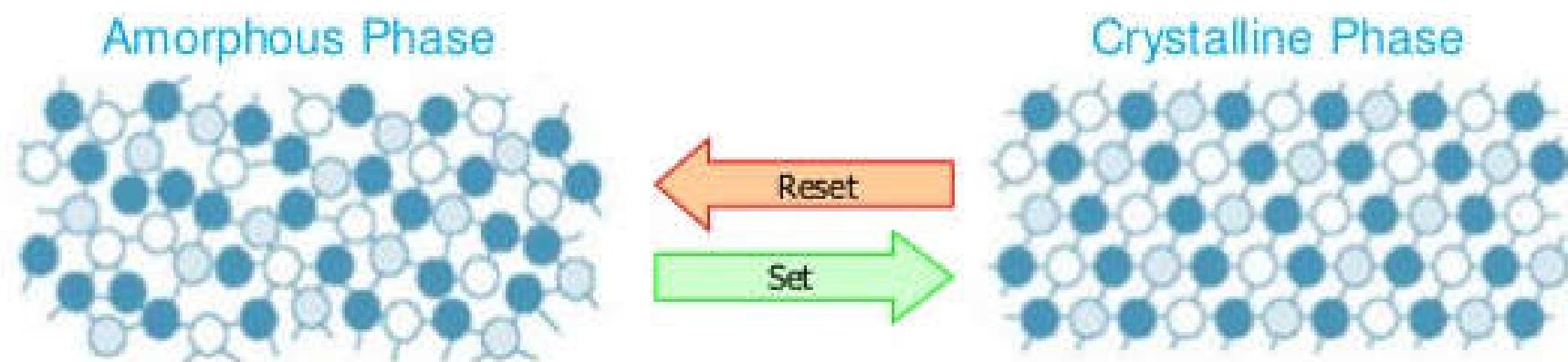
D. Shechtman  
2011 Nobel Prize in Chemistry 23

# Optical Disc

- Phase Change Memory



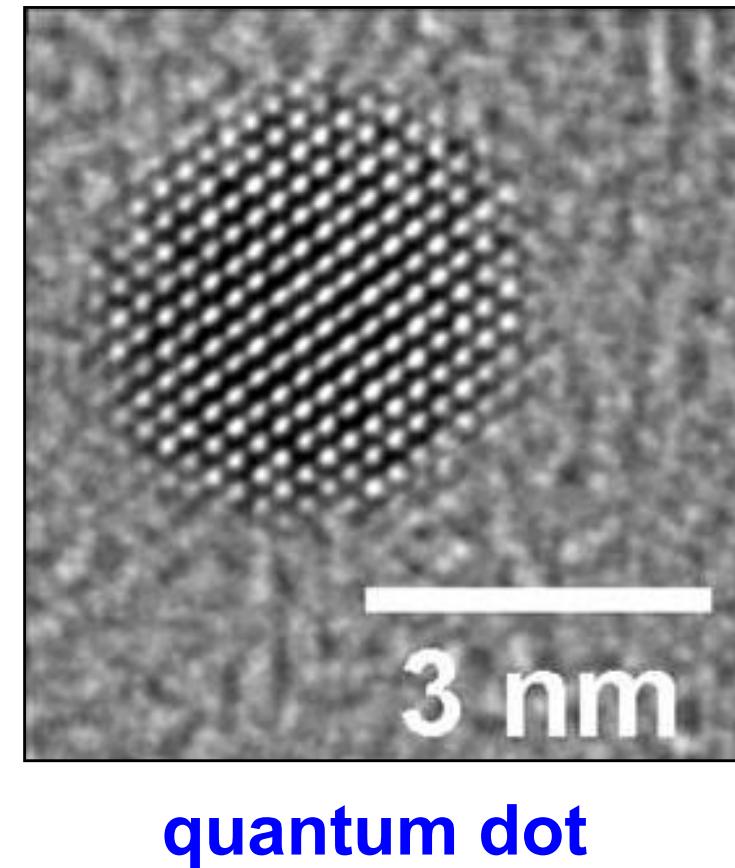
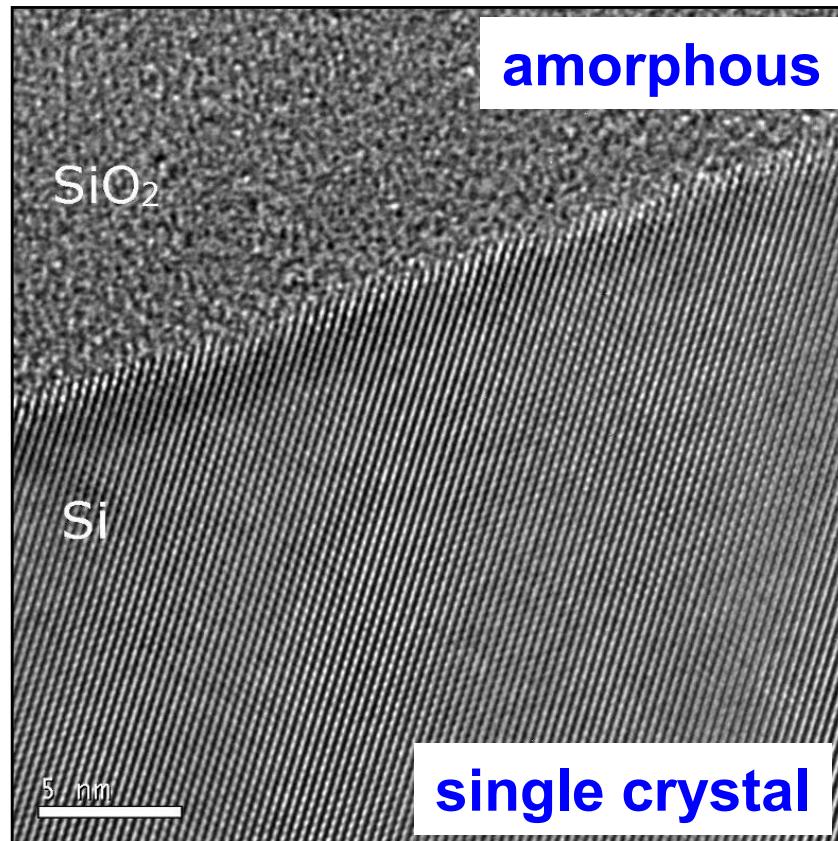
- Two Phases:



# Materials Characterization

- HRTEM

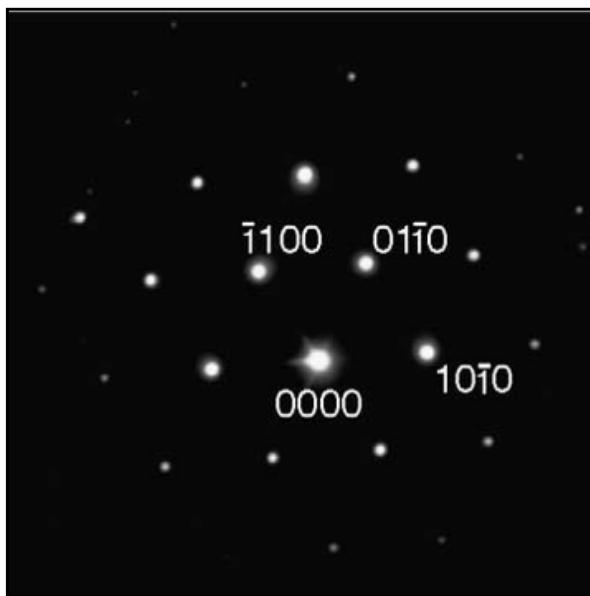
- High Resolution Transmission Electron Microscope



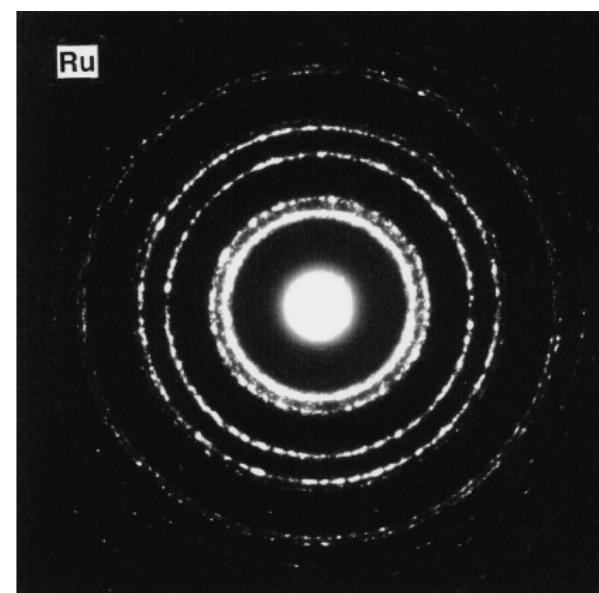
# Materials Characterization

- HRTEM
  - High Resolution Transmission Electron Microscope

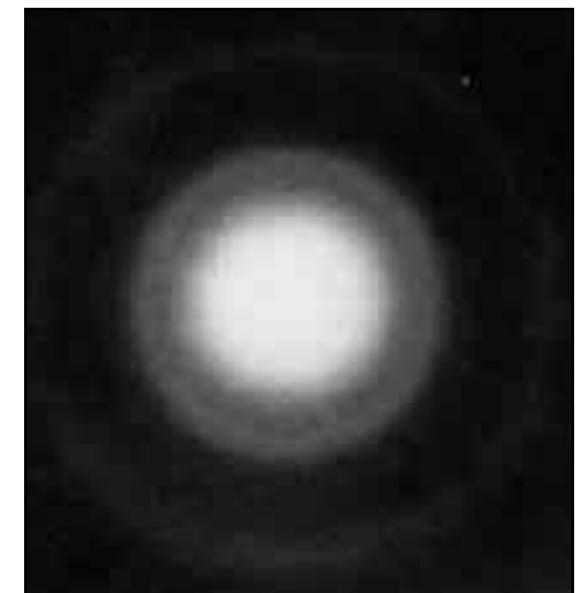
diffraction patterns



single crystal



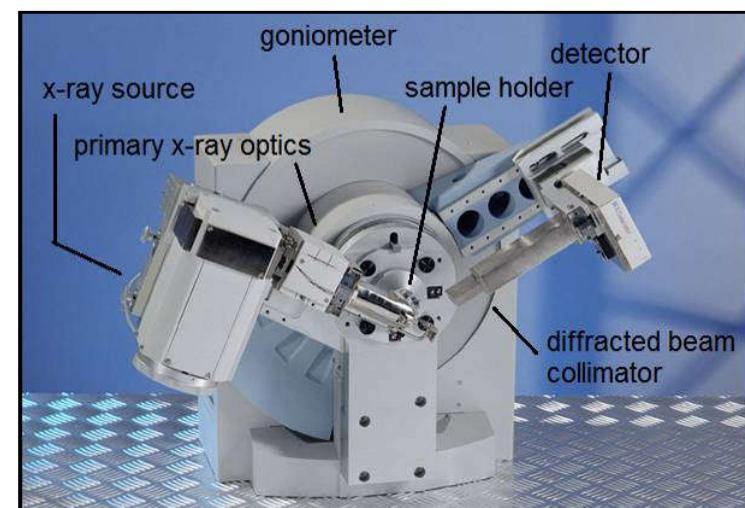
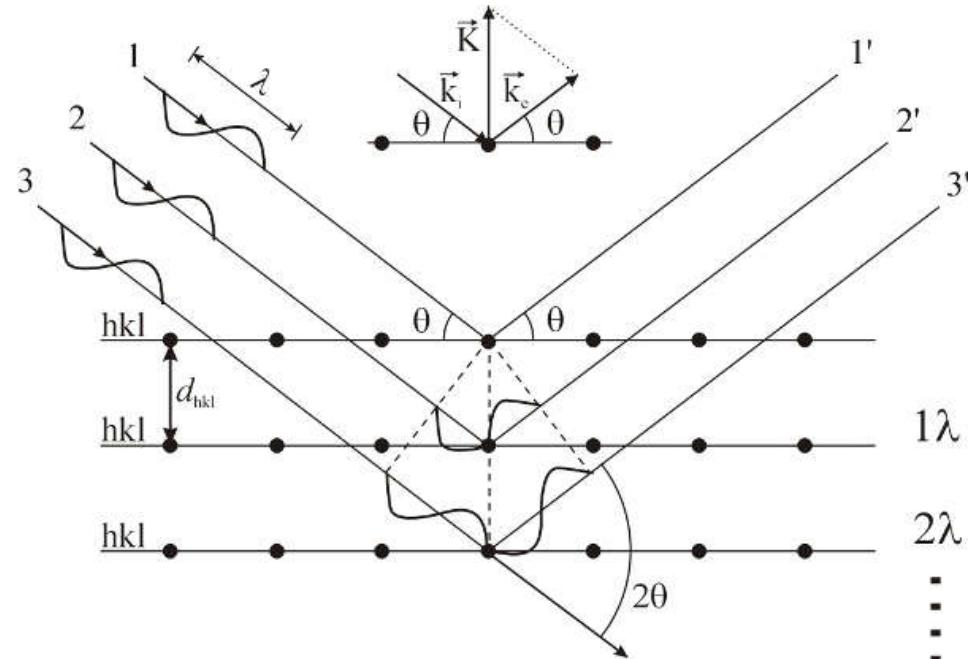
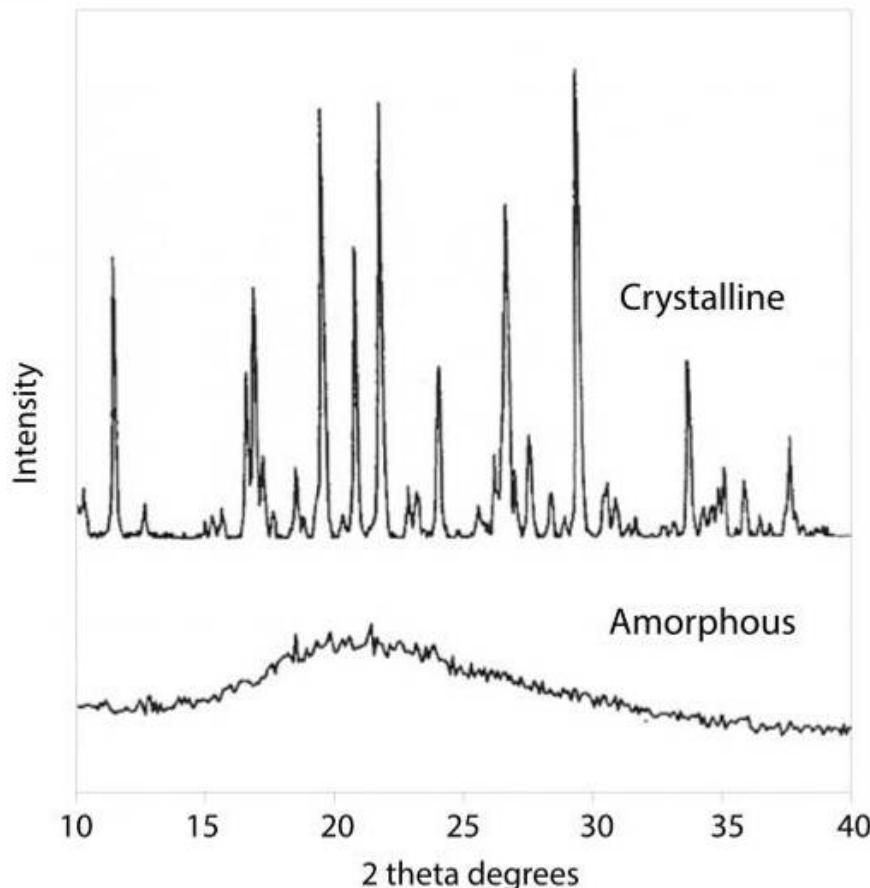
polycrystal



amorphous

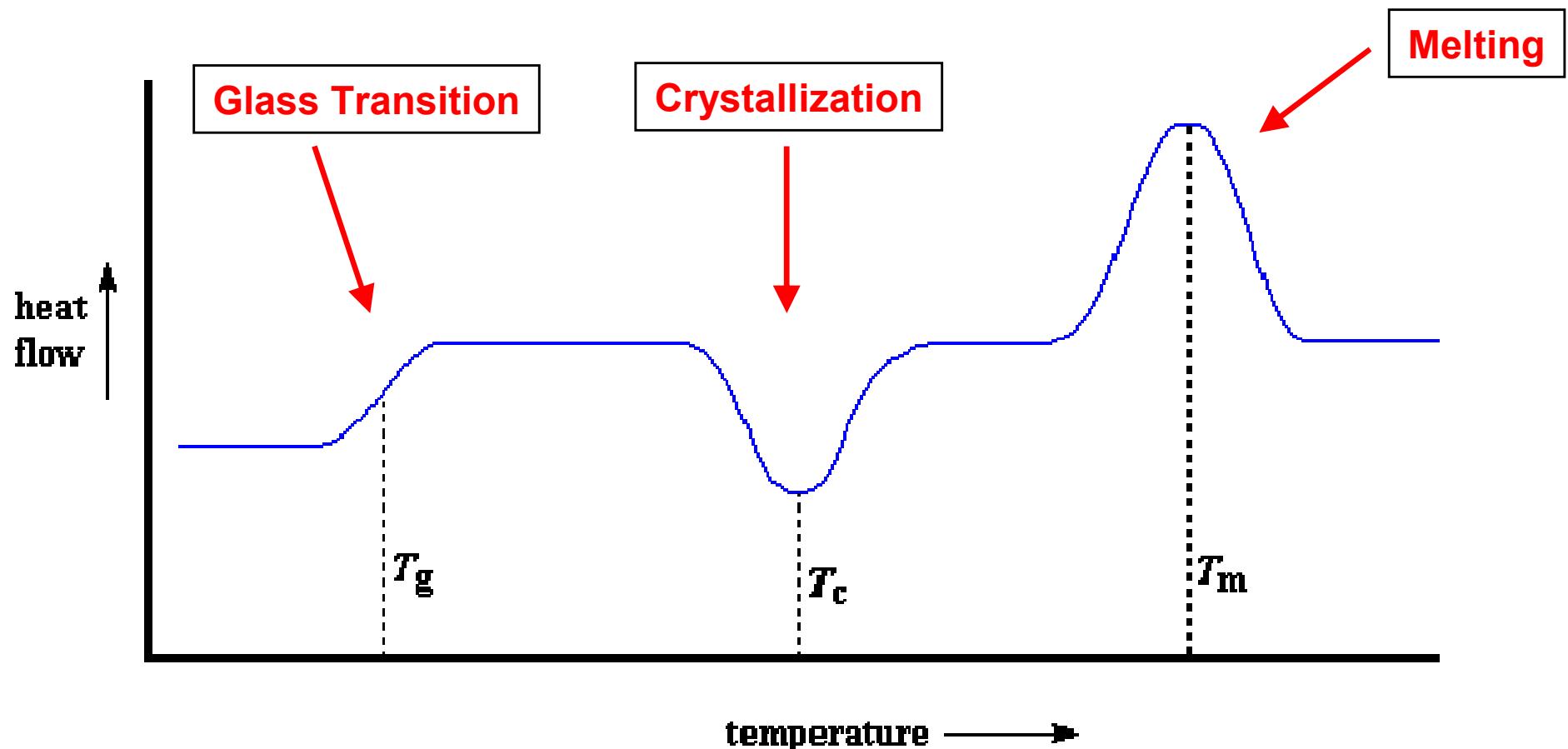
# Materials Characterization

- XRD
- X-ray Diffraction

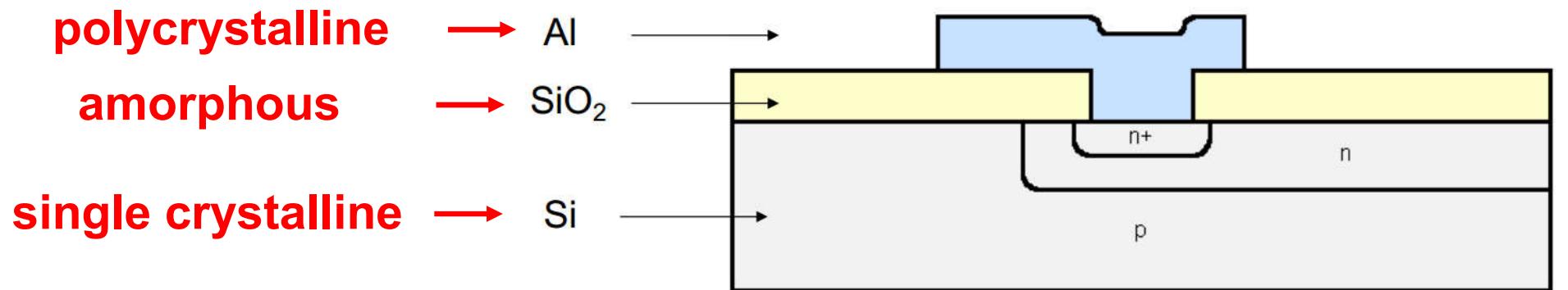


# Materials Characterization

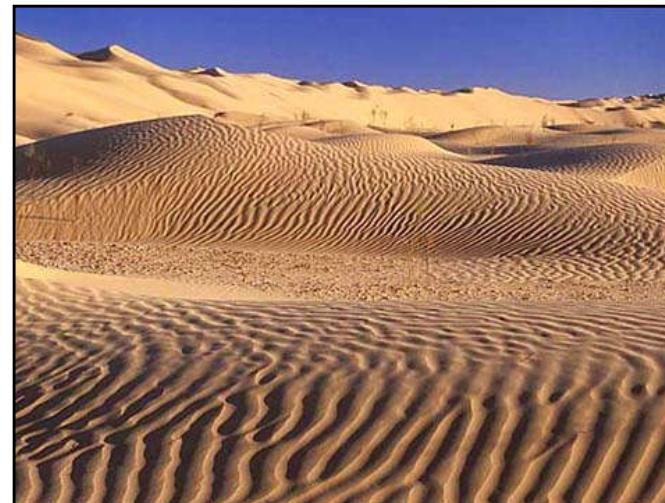
- DSC
  - Differential Scanning Calorimetry



# CMOS Device



Silicon



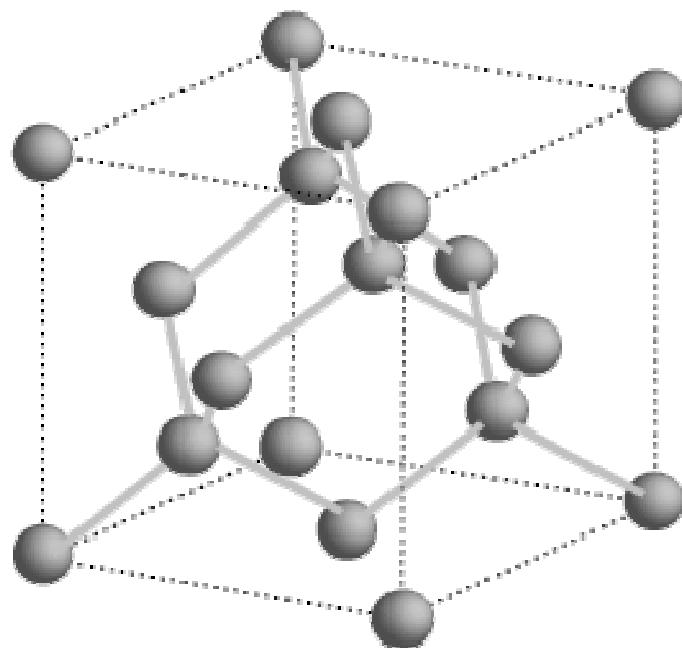
$\text{SiO}_2$



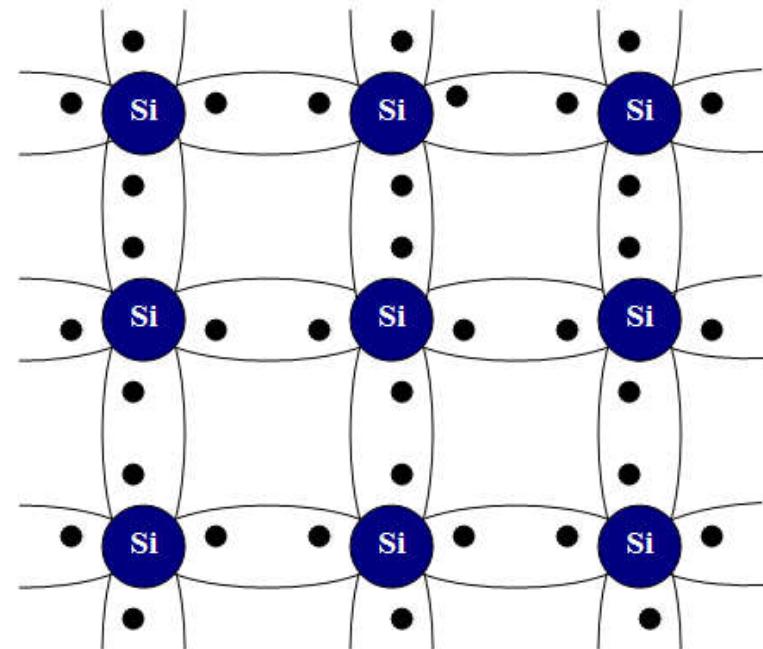
Metal

# Substrates for Devices

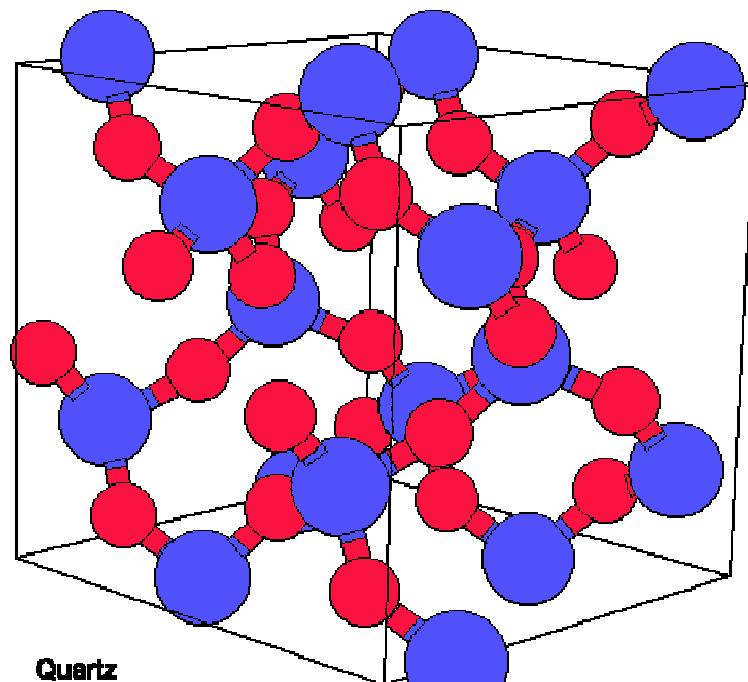
- Usually single crystals (why?)



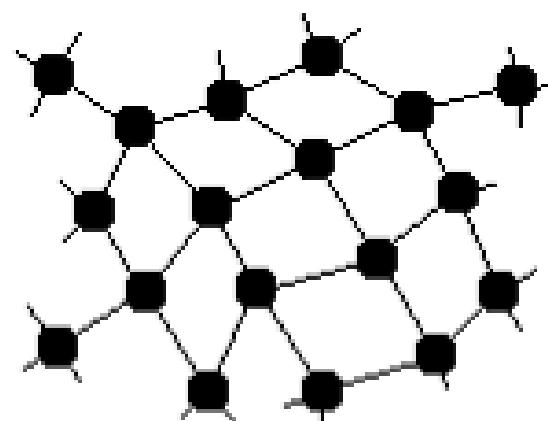
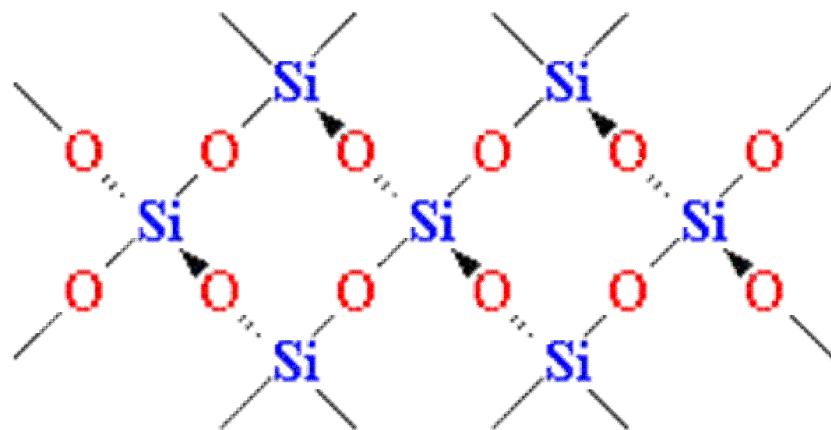
**diamond structure:**  
Si, Ge, C, ...



# Substrates for Devices

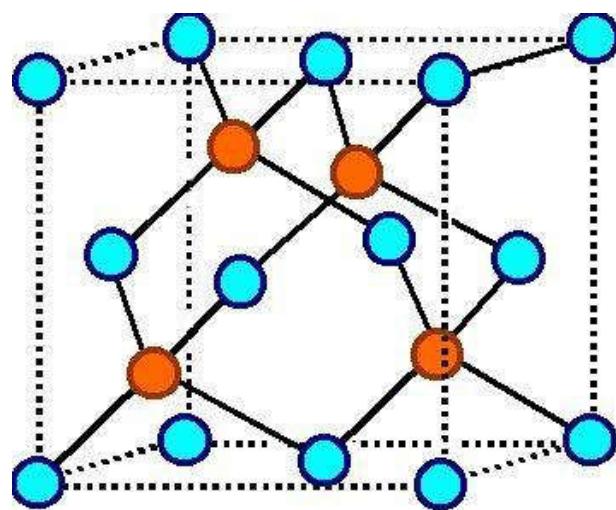


quartz ( $\text{SiO}_2$ )

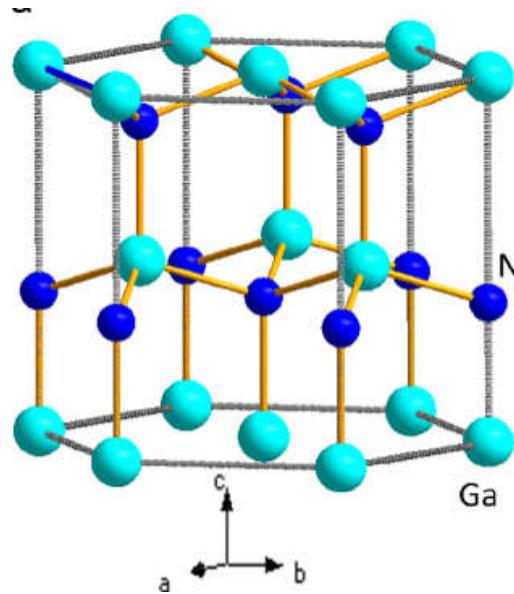


amorphous  
glass

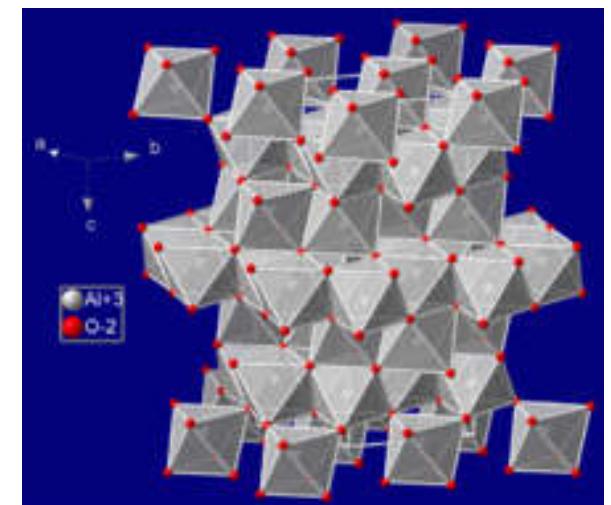
# Substrates for Devices



**zinc blende structure:**  
**GaAs, InP,  $\beta$ -SiC, ...**

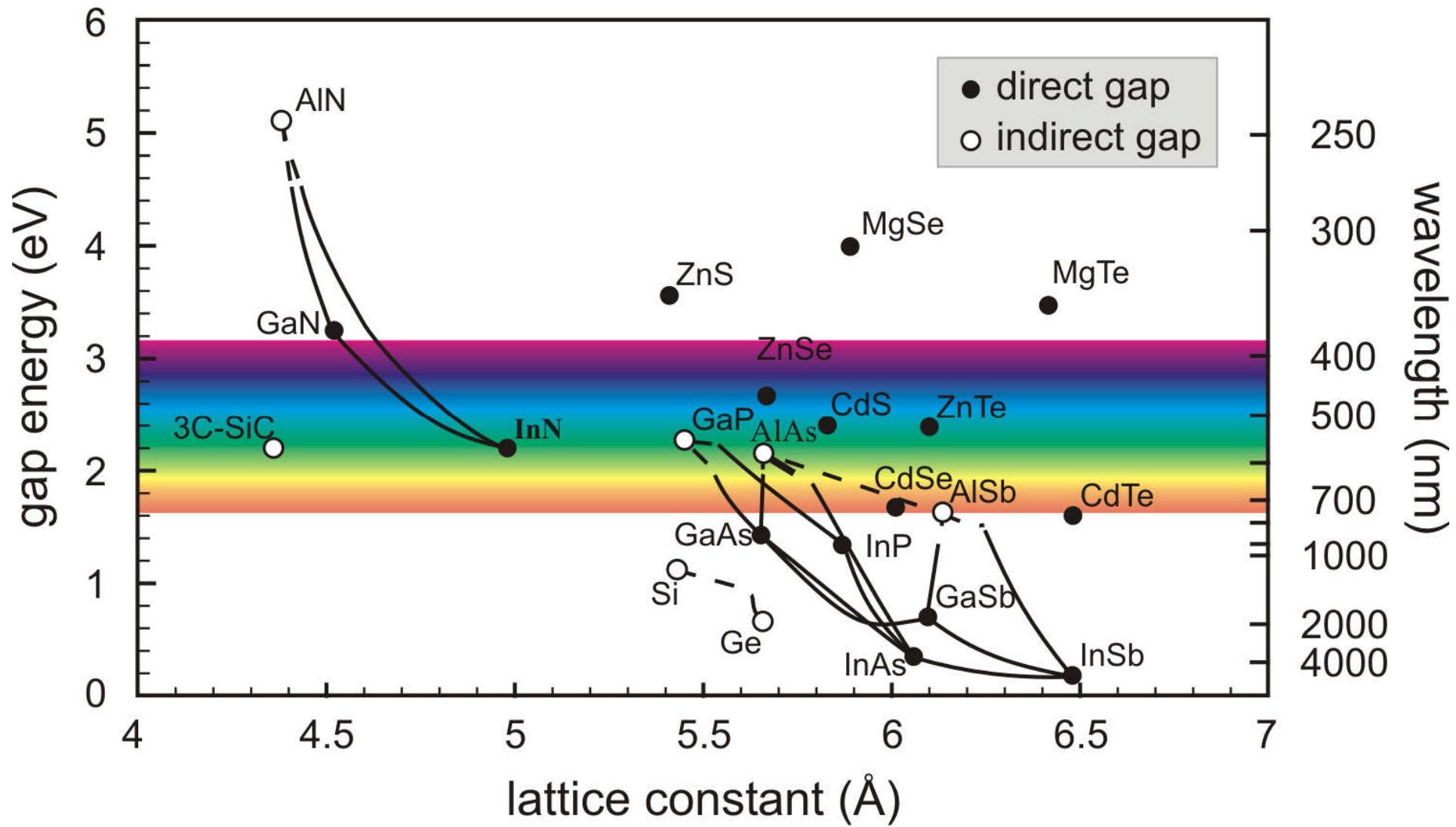


**Wurtzite structure:**  
 **$\alpha$ -SiC, GaN, ZnO, ...**



**sapphire ( $\text{Al}_2\text{O}_3$ )**

# Lattice Constants vs. Bandgap



# Requirement for Electronics

---

- low cost
- single crystal
- p-doping and n-doping
- low defect level
  - purity > 99.9999....%
  - dislocation < 1000 /cm<sup>2</sup>
- suitable bandgap
  - too large -> high voltage, power, ...
  - too small -> thermal noise, leakage, defects, ...
- semiconductor/oxide interface quality
- mobility, surface uniformity, ...

# Silicon vs. Germanium

## Silicon

- earth abundant
  - > 25% on earth
- perfect Si/SiO<sub>2</sub> interface
- bandgap 1.1 eV

vs.

## Germanium

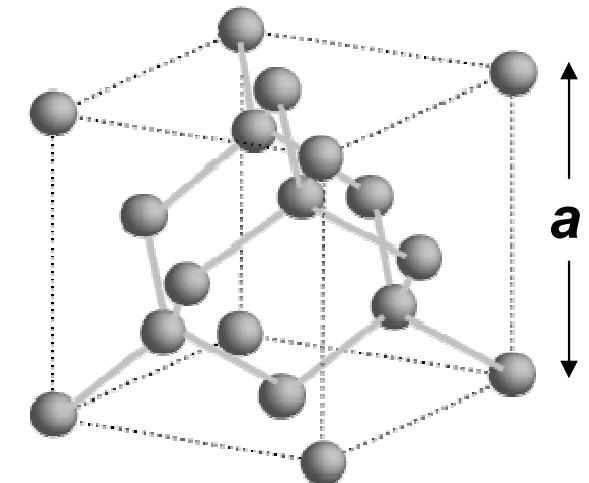
- expensive
- GeO<sub>2</sub> is not stable
- bandgap 0.67 eV

*Silicon wins  
and will always win (?)*

# Properties of Silicon

## ■ Structural

- diamond structure (FCC)
- lattice constant  $a = 5.431 \text{ \AA}$
- atomic density =  $5 \times 10^{22} / \text{cm}^3$
- melting point =  $1417^\circ \text{ C}$



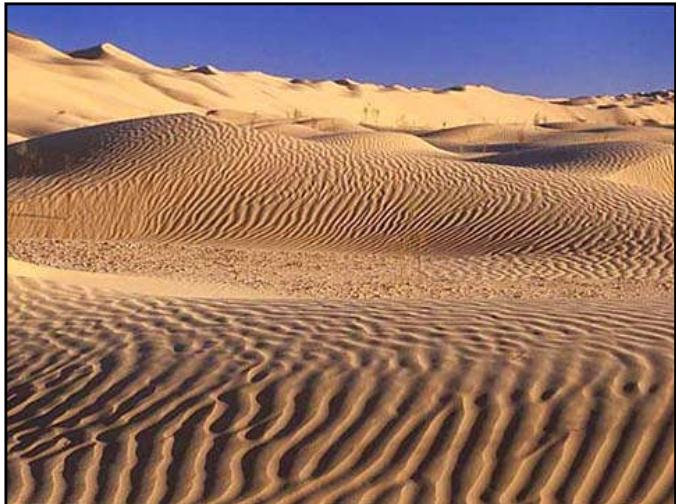
## ■ Electronic

- bandgap  $E_g = 1.12 \text{ eV}$
- dielectric constant  $\epsilon_r = 11.9$
- mobility: electron  $\mu_e = 1500 \text{ cm}^2/\text{V}\cdot\text{s}$ , hole  $\mu_h = 450 \text{ cm}^2/\text{V}\cdot\text{s}$
- intrinsic carrier density  $n_i = 1.45 \times 10^{10} / \text{cm}^3$

## ■ Optical

- refractive index  $n = 3.6$
- absorbs < 1100 nm, transparent > 1100 nm

# How to Make Silicon Wafers?

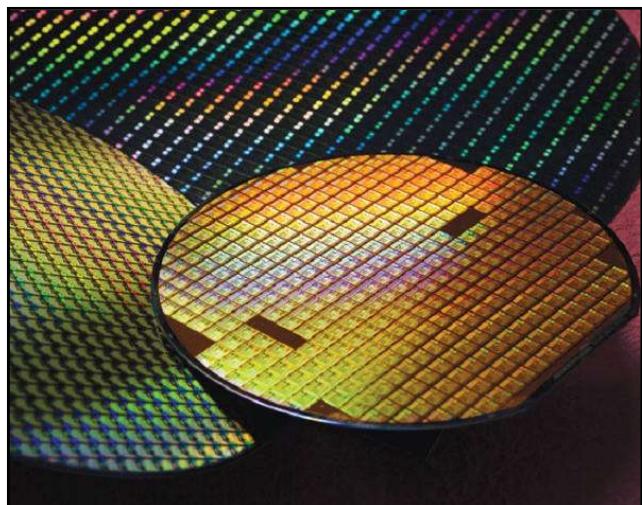


$\text{SiO}_2$



[Video](#)

raw Si

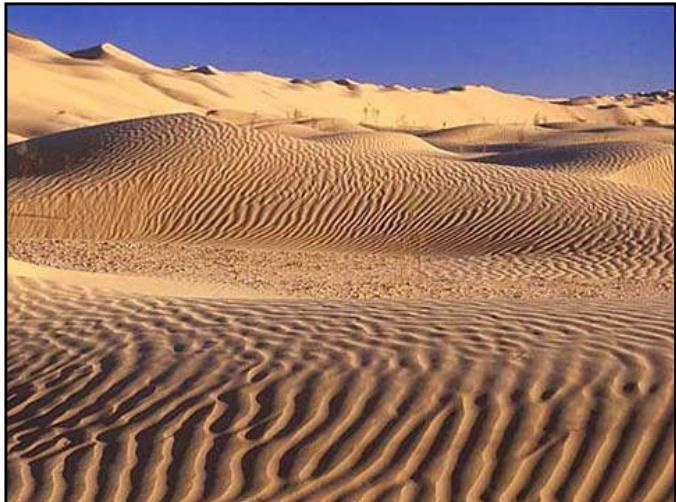


IC chips



Si ingots and wafers

# How to Make Silicon Wafers?



$\text{SiO}_2$



raw Si



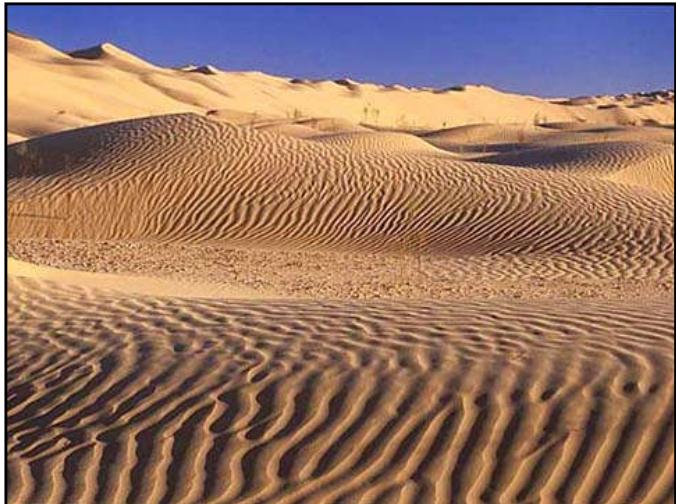
at 2000 °C



Metallurgical Grade Silicon, purity ~ 98%

Applications: aluminum, silicone, ...

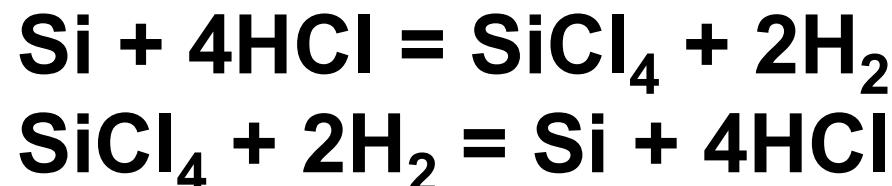
# How to Make Silicon Wafers?



$\text{SiO}_2$



raw Si



purification  
(Siemens process)



**Polycrystalline Silicon, purity > 99.99%**  
**Applications: solar cells, ...**

# How to Make Silicon Wafers?

**poly crystal -> single crystal**

**Czochralski process (CZ)**

**Float-zone process (FZ)**



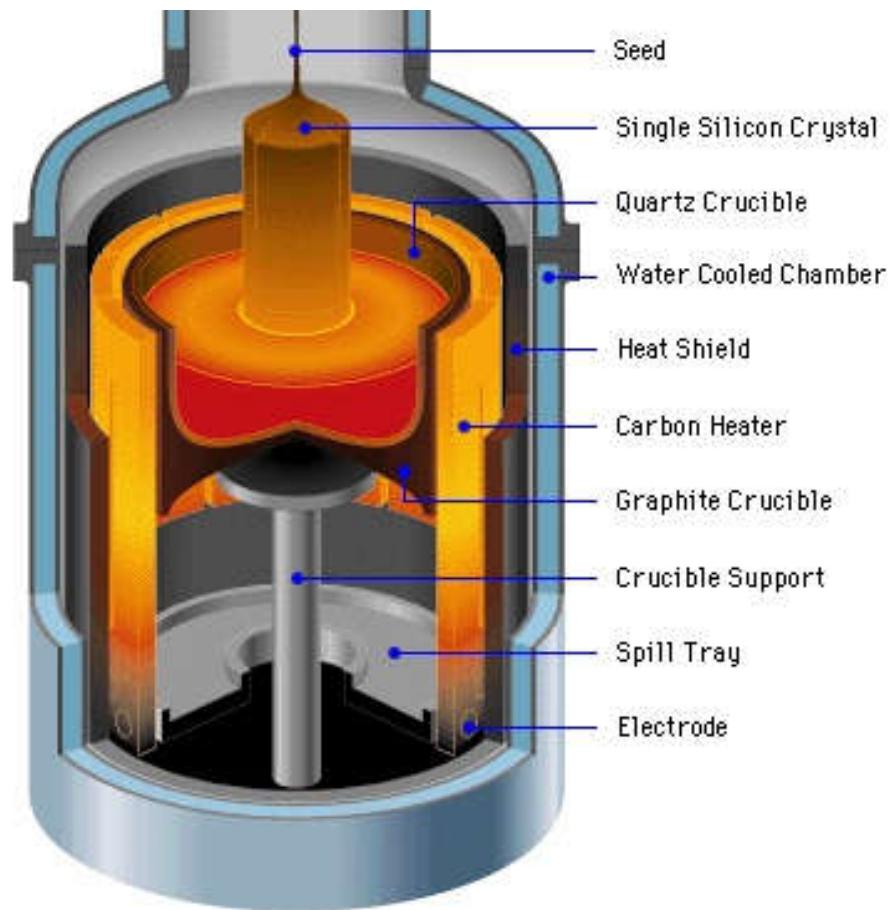
**raw Si**



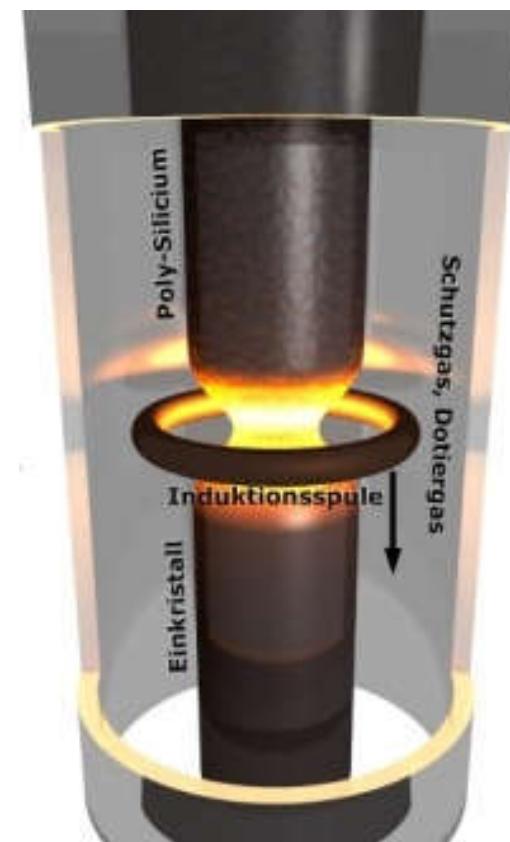
**Si ingots and wafers**

# How to Make Silicon Wafers?

## Czochralski process (CZ)

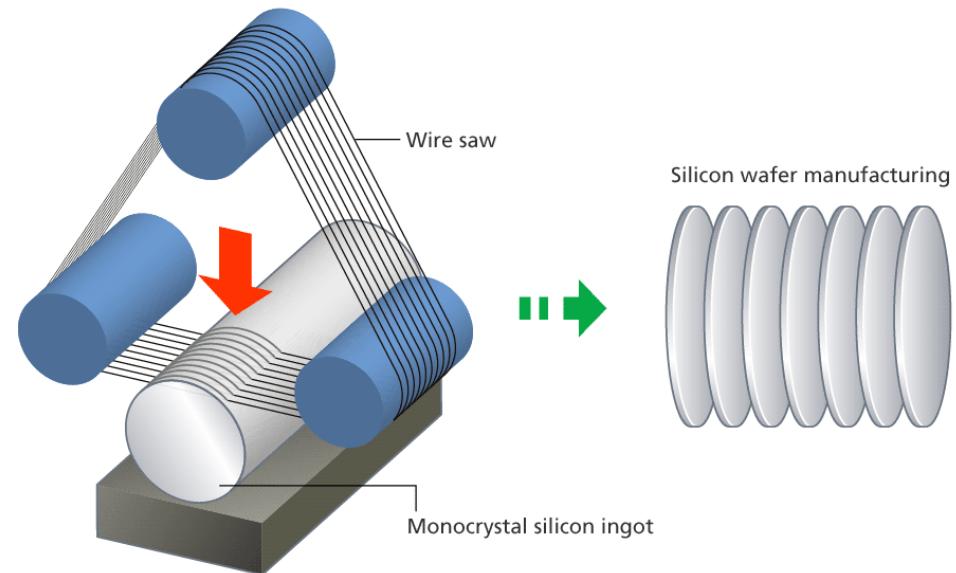


## Float-zone process (FZ)

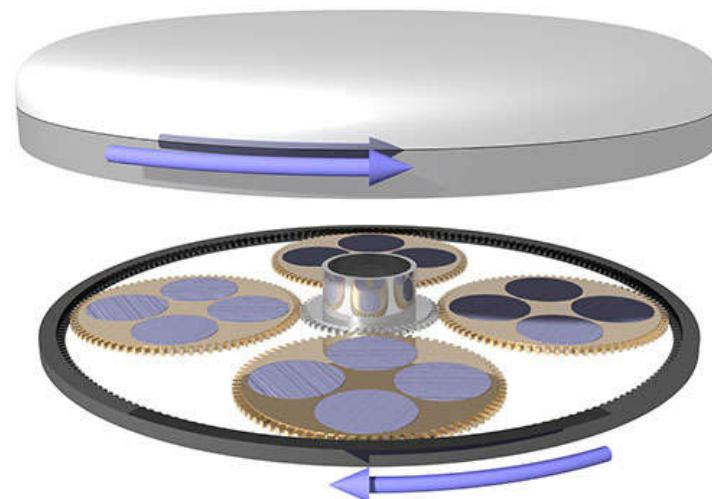


# How to Make Silicon Wafers?

**wafer slicing**



**wafer polishing**



# Silicon wafers: size

**4 inch    6 inch    8 inch    12 inch    18 inch**

100mm

150mm

200mm

300mm

450mm

1975

1980

1990

2001

2017



**18 inch wafer**

# Silicon wafers: purity

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## ■ Metallurgical grade

- polycrystalline
- purity > 98%
- application: aluminum alloy, silicone

## ■ Solar grade

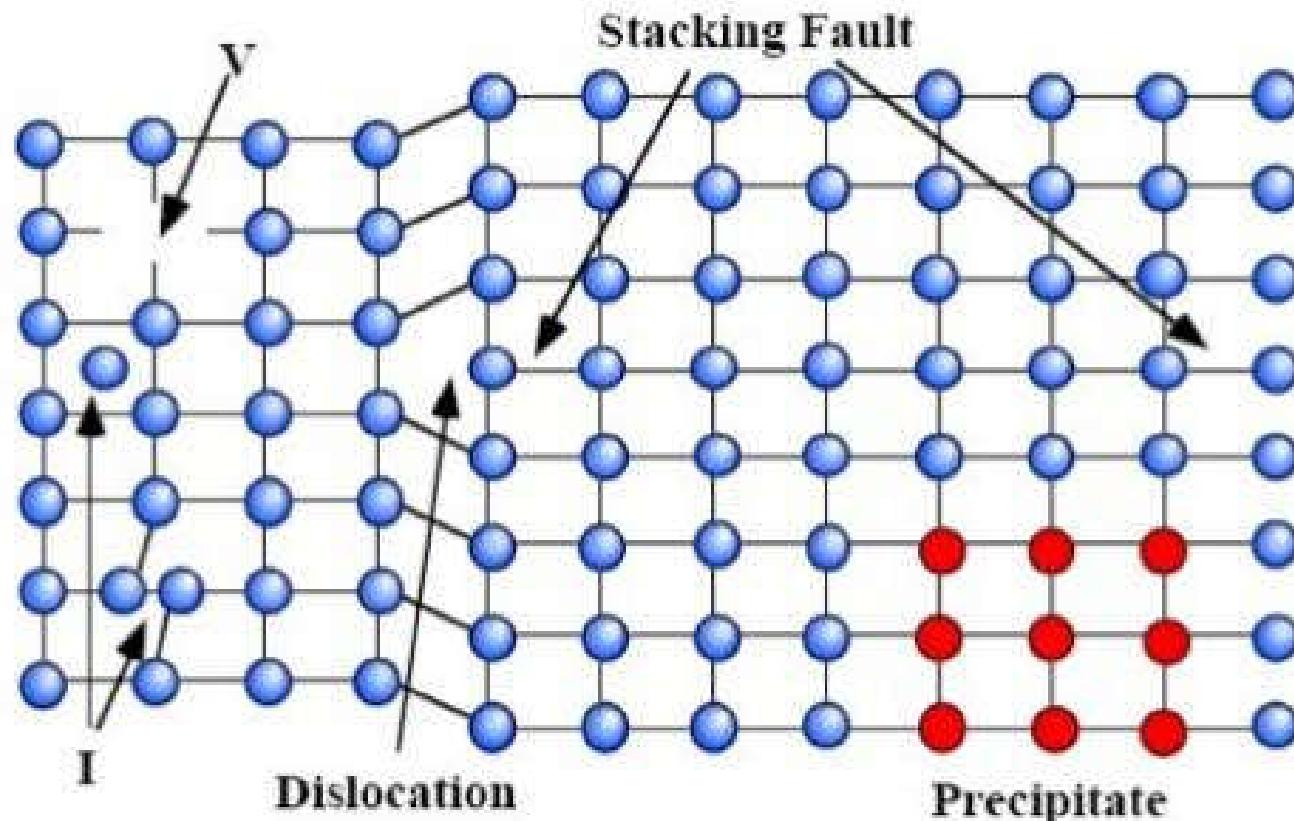
- polycrystalline
- purity > 99.99% (4N)
- application: solar cells

## ■ Electronic grade

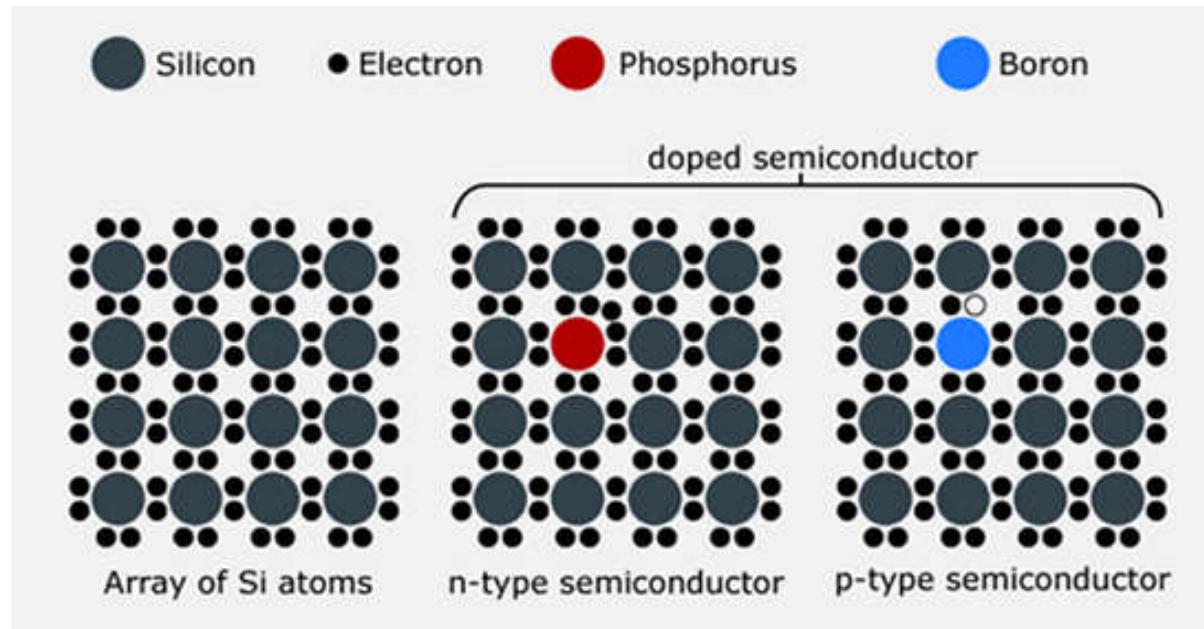
- single crystalline
- purity > 99.9999999% (9N)
- application: IC industry, high efficiency solar cells

# Silicon wafers: defects

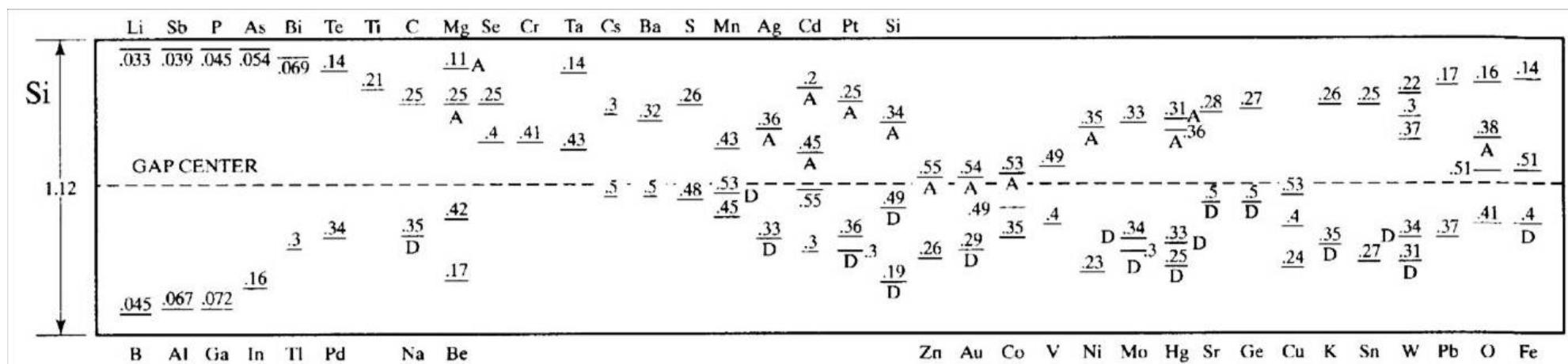
- Point Defects e.g. Vacancies (V), Interstitials (I)
- Line Defects e.g. Dislocations
- Area Defects e.g. Stacking Faults ("extrinsic" or "intrinsic" form along {111} planes)
- Volume Defects e.g. Precipitates, Collection of Vacancies



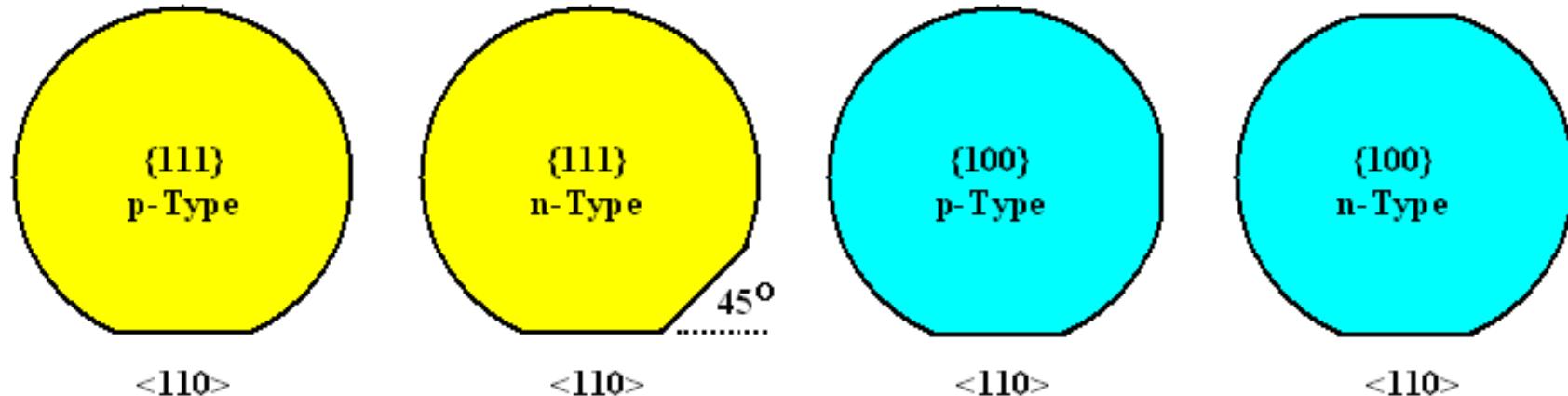
# Silicon wafers: doping



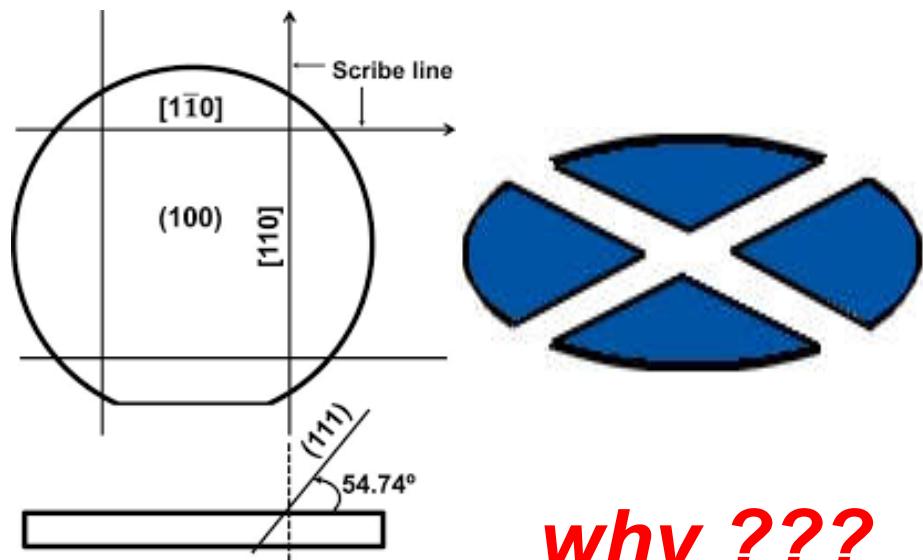
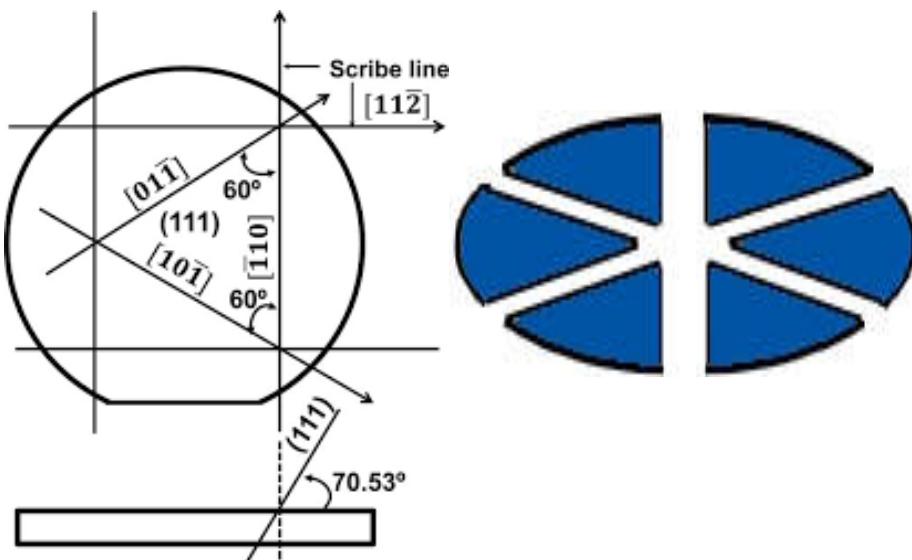
5	6	7	8	9	10		
B	C	N	O	F	Ne		
13	14	15	16	17	18		
Al	Si	P	S	Cl	Ar		
31	32	33	34	35	36		
Ga	Ge	As	Se	Br	Kr		
49	50	51	52	53	54		
In	Sn	Sb	Te	I	Xe		
81	82	83	84	85	86		
Tl	Pb	Bi	Po	At	Rn		



# Silicon wafers: orientation



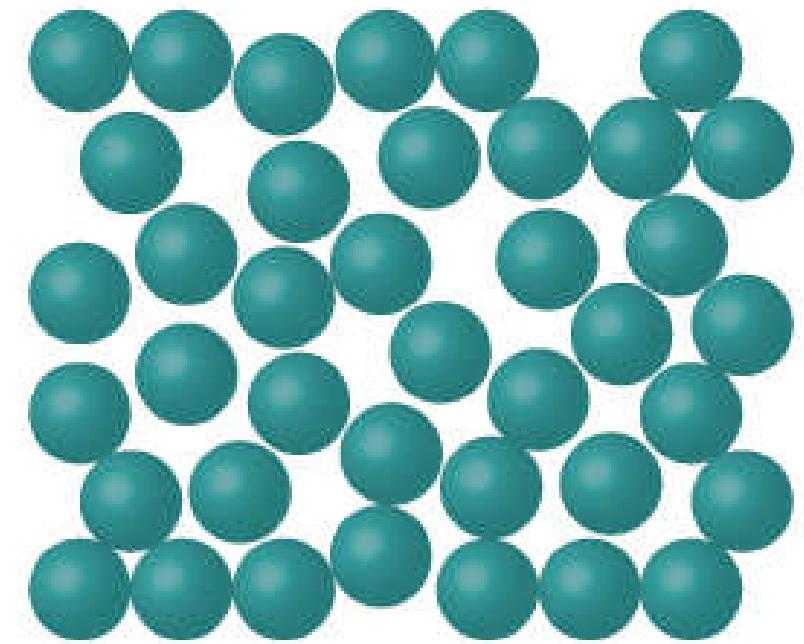
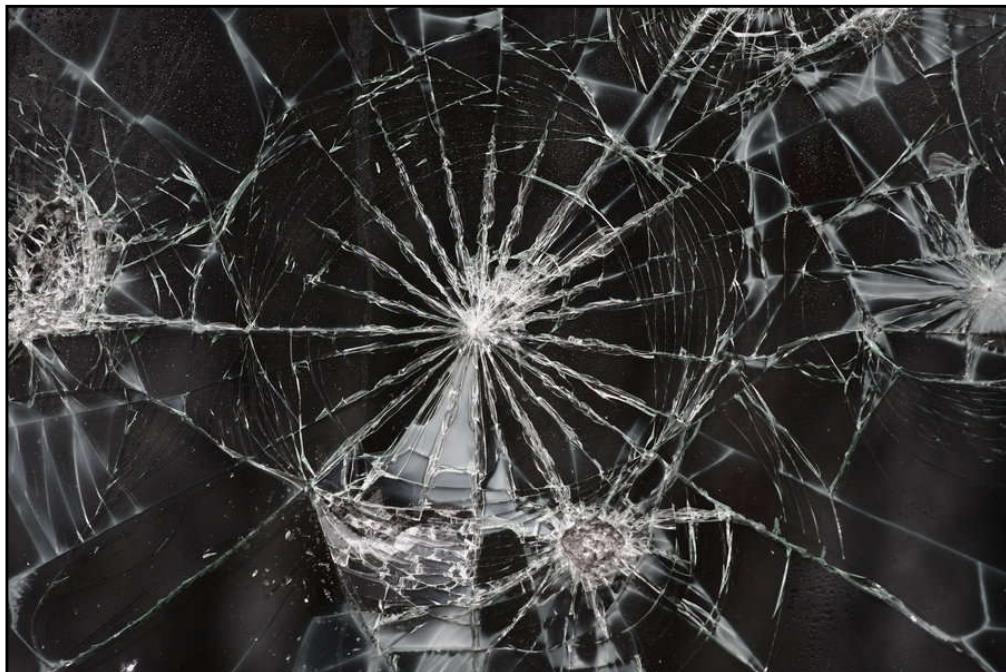
## cleavage direction



**why ???**

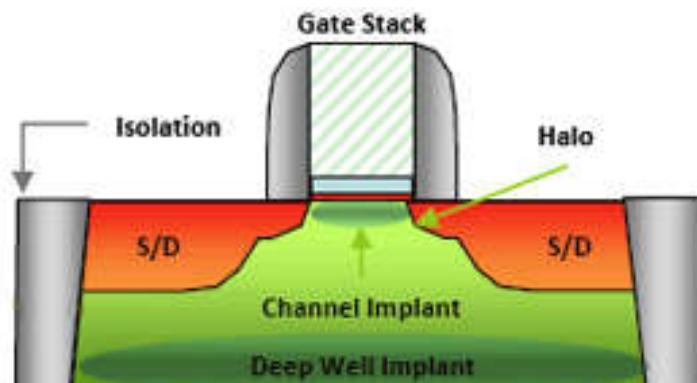
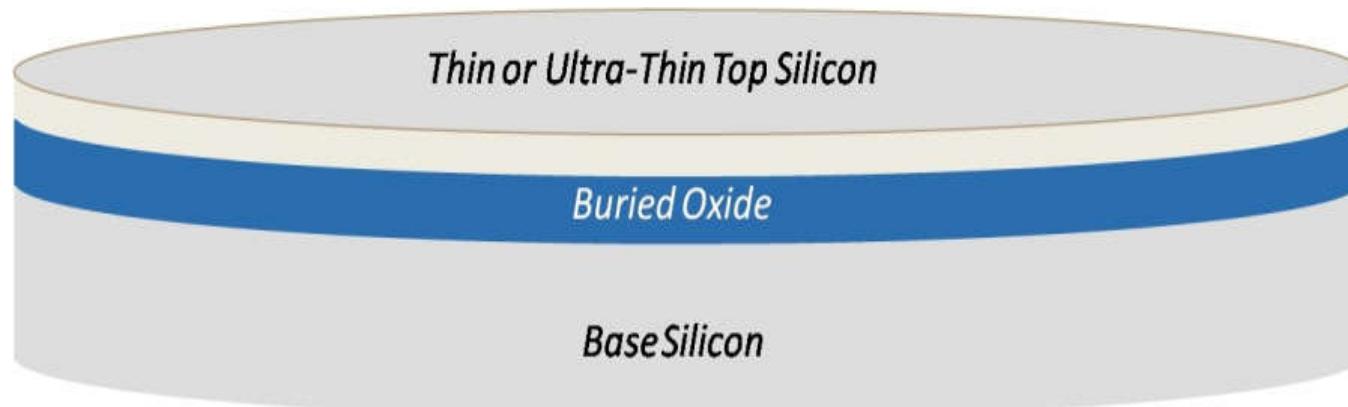
# Breaking Amorphous Materials

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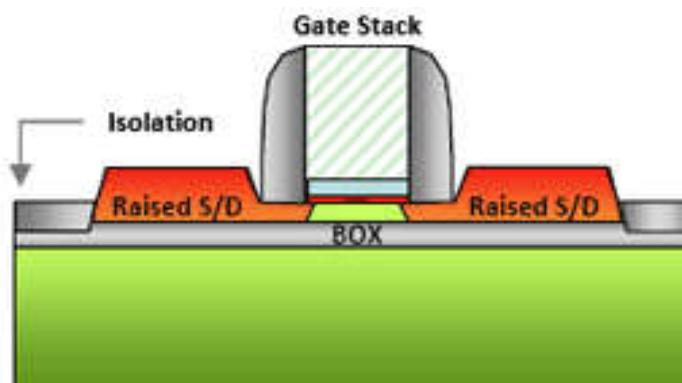
Amorphous

# Silicon-on-Insulator (SOI)

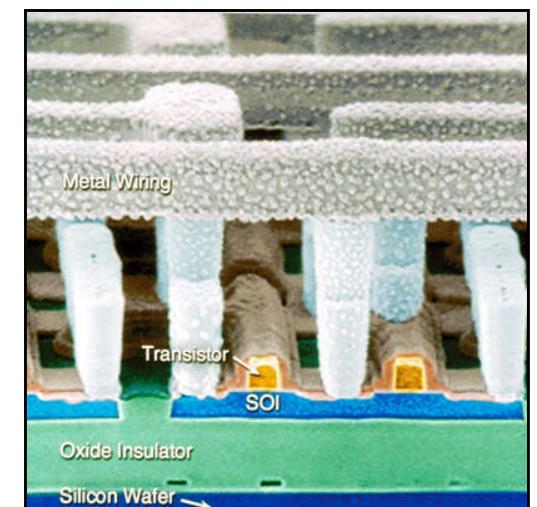


Bulk Device

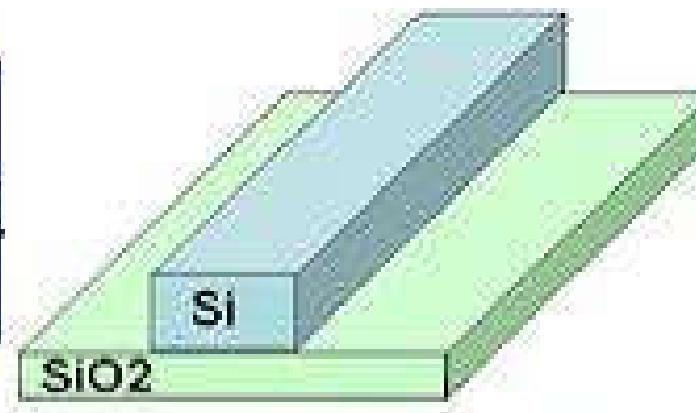
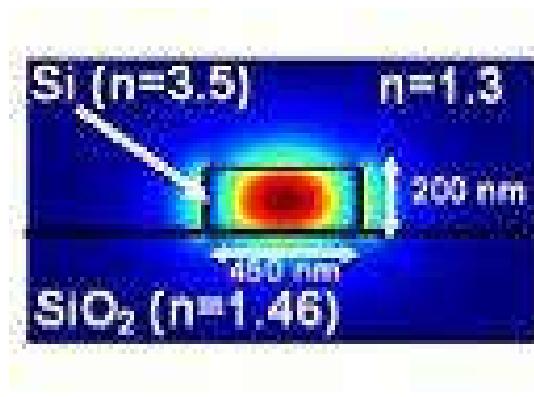
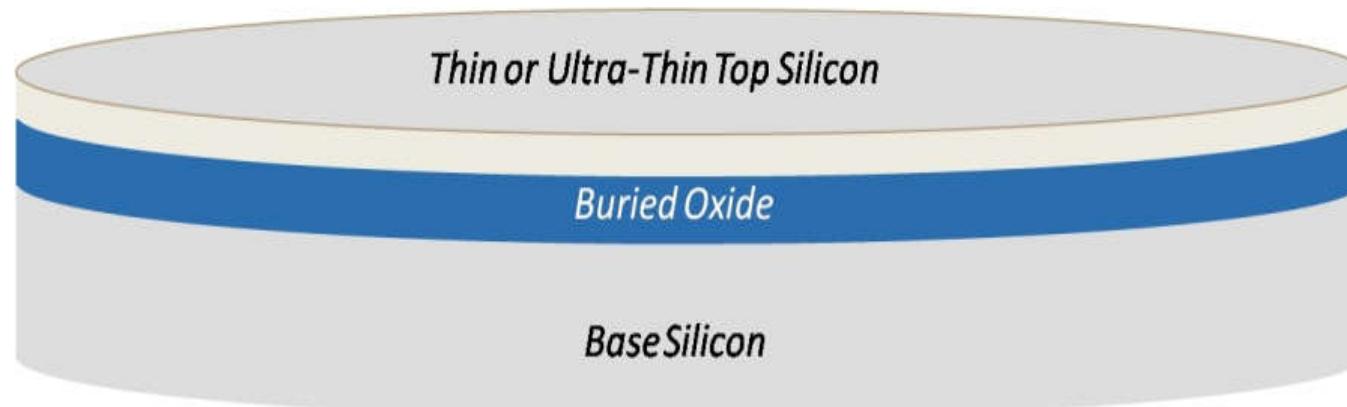
The fully depleted SOI transistor at 20 nm is significantly simpler than even a simplified version of the bulk CMOS transistor.



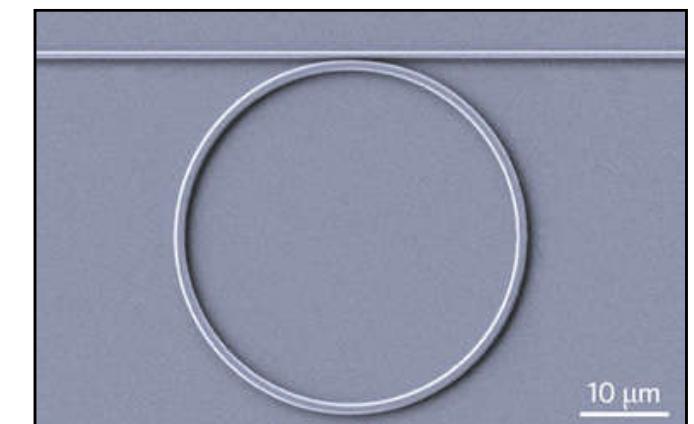
FD-SOI Device



# Silicon-on-Insulator (SOI)



**Silicon waveguide**



**Ring resonator**

# Other single crystals



Ge



GaAs

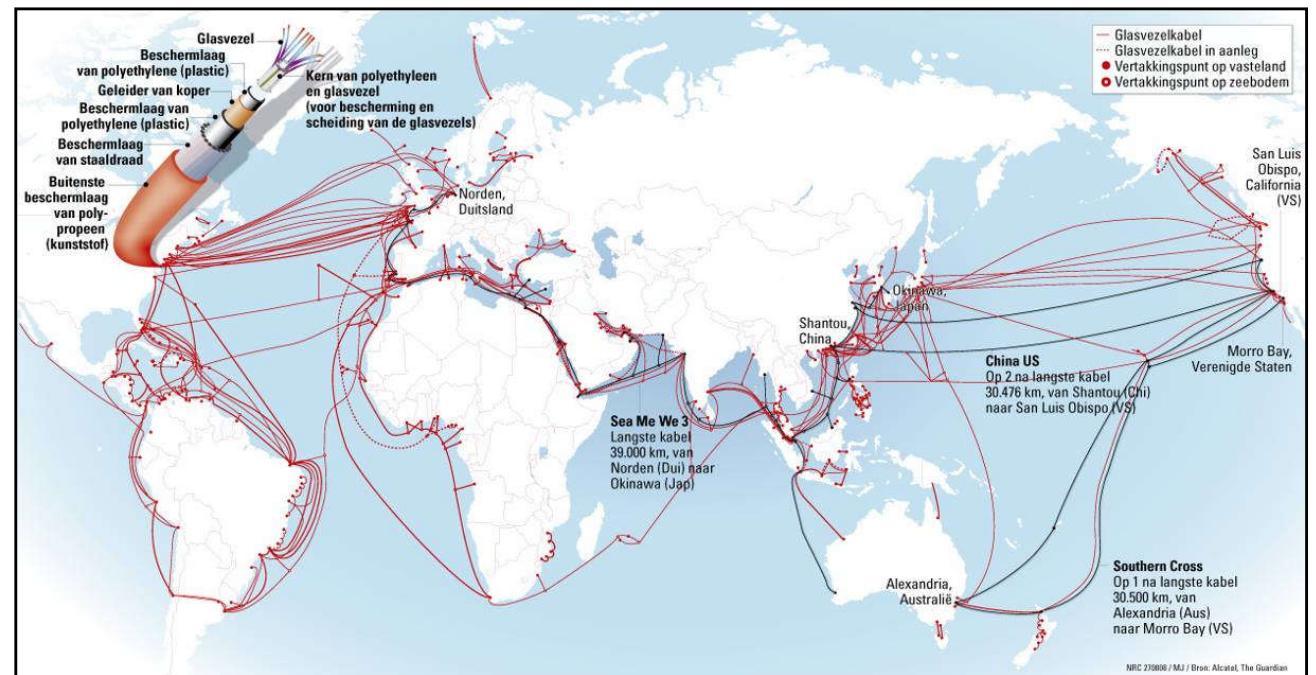
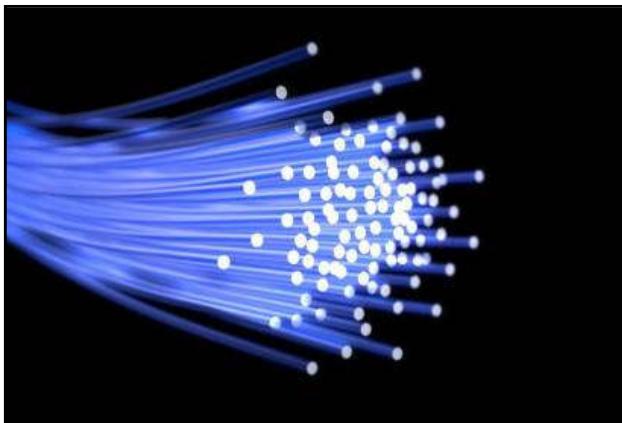


sapphire



**Q: Can we make diamond crystal?**

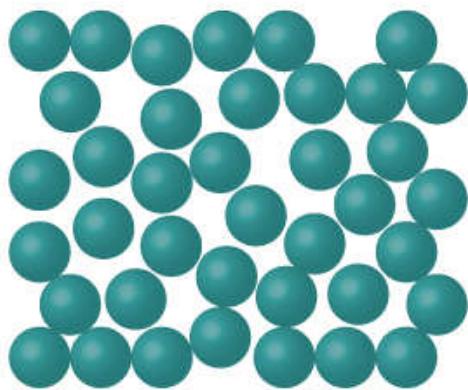
# Optical Fibers



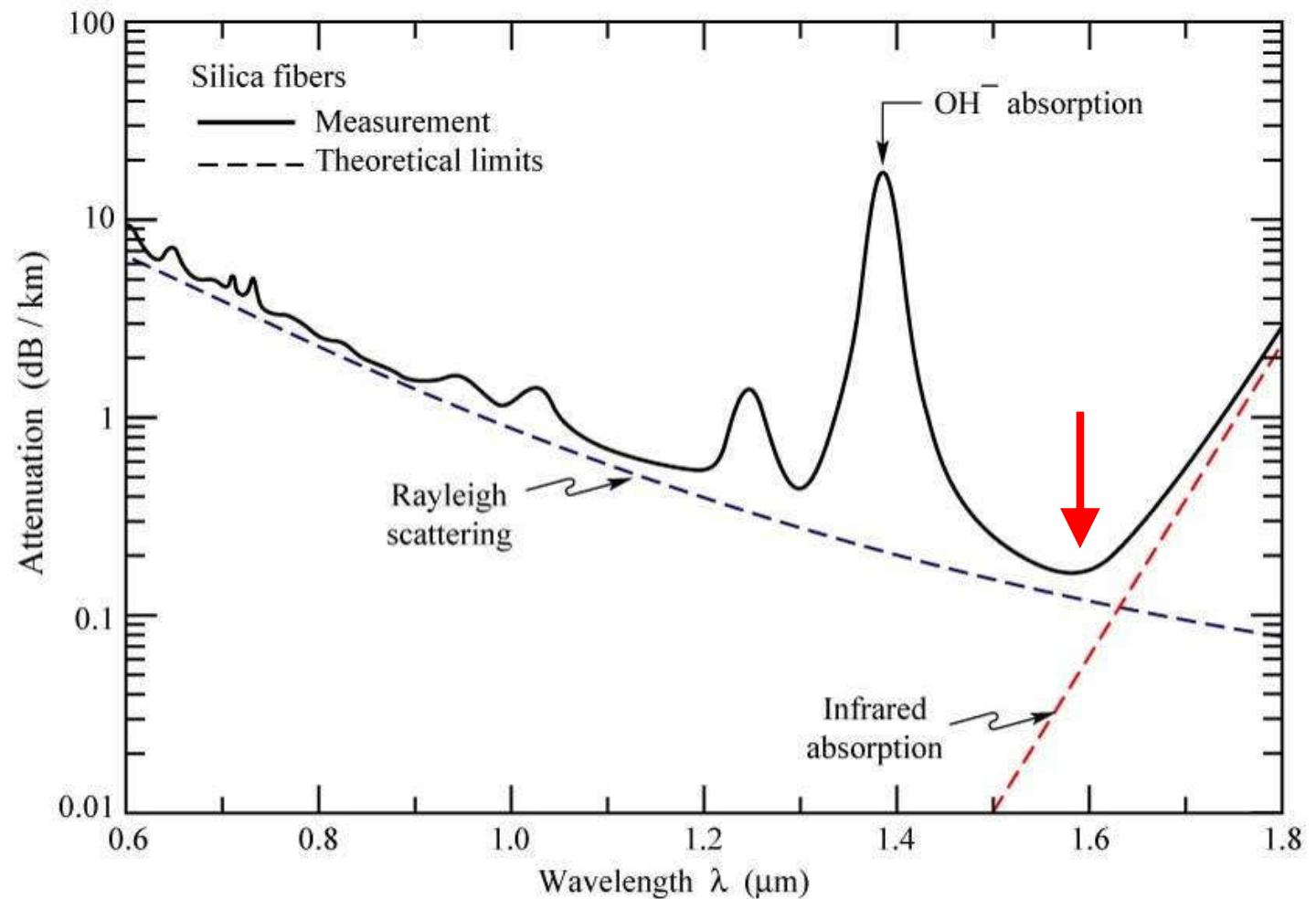
**K. Kao (高锟)  
2009 Nobel Prize in Physics**

K. C. Kao, G. A. Hockham, *Proc. IEE* **113**, 1151 (1966)

# Absorption of Silica ( $\text{SiO}_2$ )



Amorphous



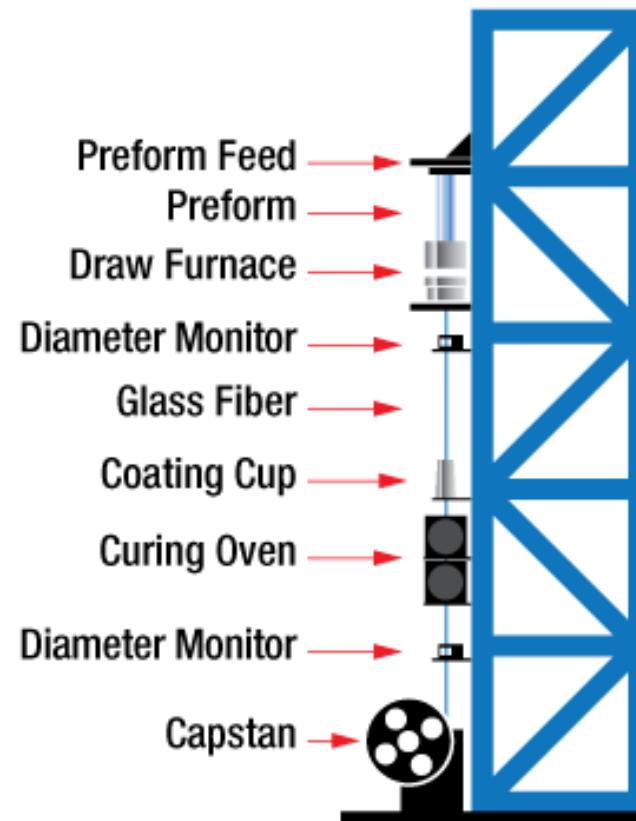
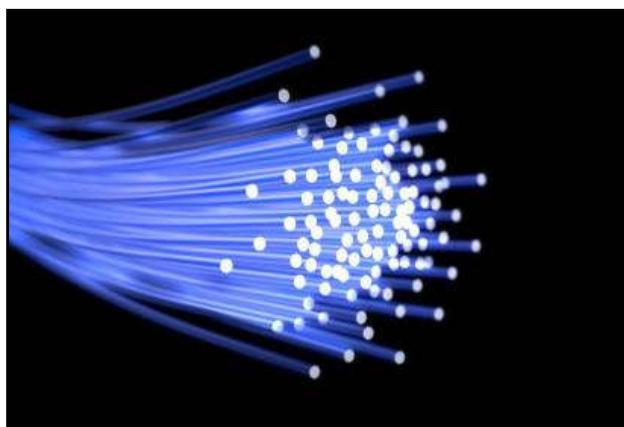
minimum loss at 1550 nm, 0.2 dB/km  
~ 2% loss every kilometer

# Optical Fiber Drawing

preform



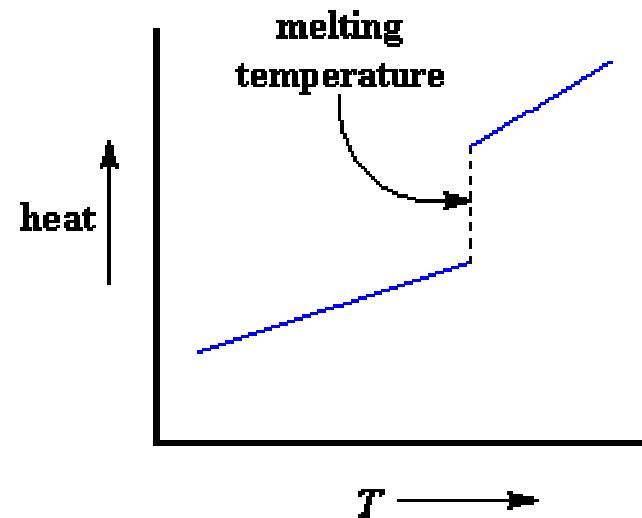
fibers



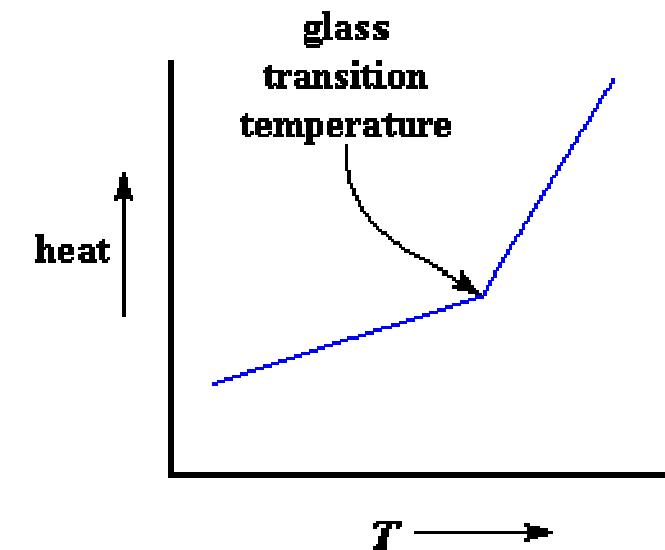
[Video](#)

# Glass Transition

‘吹’ 玻璃



1st order transition



2nd order transition

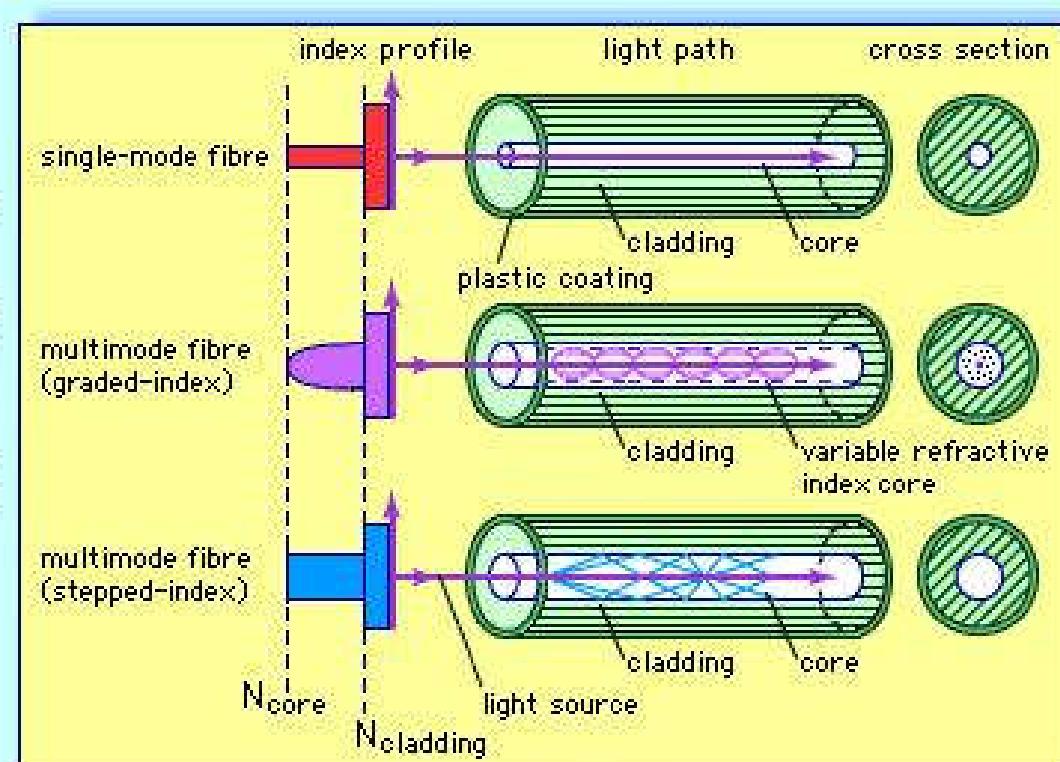
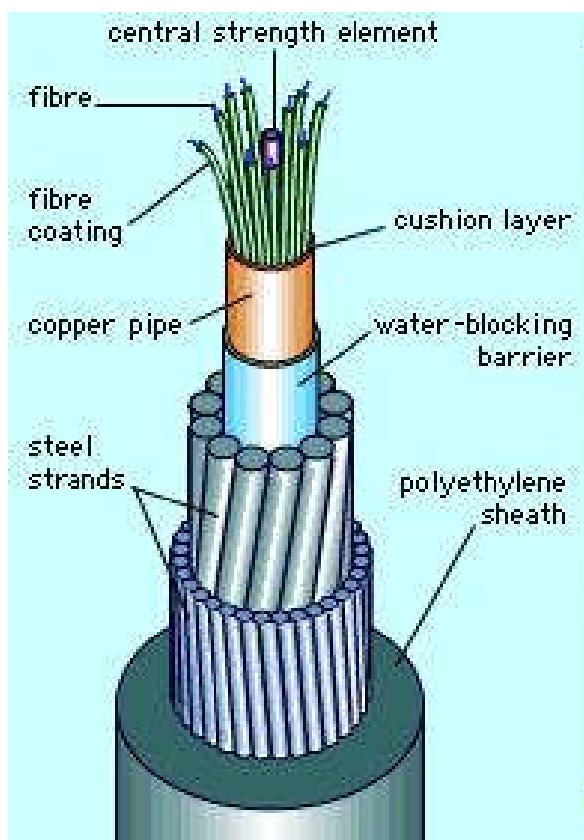


glassy / plastic state



viscous / rubbery state

# Optical Fibers



*Thank you for your attention*